





# **FEATURES AND BENEFITS**

- Contactless 0° to 360° angle sensor IC, for angular position, rotational speed, and direction measurement
	- $\square$  Capable of sensing magnet rotational speeds targeting 12b effective resolution with 900 G field
	- $\Box$  Circular Vertical Hall (CVH) technology provides a single channel sensor system supporting operation across a wide range of air gaps
- Low power mode and turns counter enable tracking of motor position even when vehicle is turned off
- Developed in accordance with ISO 26262:2011 requirements for hardware product development for use in safety-critical applications
	- □ Single die version designed to meet ASIL B requirements when integrated and used in conjunction with the appropriate system-level control, in the manner prescribed in the A1339 Safety Manual
	- □ Dual die version designed to meet ASIL D requirements when integrated and used in conjunction with the appropriate system-level control, in the manner prescribed in the A1339 Safety Manual
- High diagnostic coverage
	- $\Box$  On-chip diagnostics include logic built-in self-test (LBIST), signal path diagnostics, and watchdogs to support safety-critical (ASIL) applications
	- □ 4-bit CRC on SPI

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## **DESCRIPTION**

The A1339 is a 360° angle sensor IC that provides contactless high-resolution angular position information based on magnetic Circular Vertical Hall (CVH) technology. It has a system-onchip (SoC) architecture that includes: a CVH front end, digital signal processing, and motor commutation (UVW) or encoder outputs (A, B, I). It also includes on-chip EEPROM technology, capable of supporting up to 100 read/write cycles, for flexible end-of-line programming of calibration parameters. The A1339 is ideal for automotive applications requiring  $0^{\circ}$  to  $360^{\circ}$  angle measurements, such as electronic power steering (EPS), rotary PRNDLs, and throttle systems.

The A1339 supports customer integration into safety-critical applications.

The A1339 is available in a dual-die 24-pin eTSSOP and a single-die 14-pin TSSOP package. The packages are lead (Pb) free with 100% matte-tin leadframe plating.

### **PACKAGES:**

24-pin eTSSOP (Suffix LP) 14-pin TSSOP (Suffix LE)





Dual Independent SoCs

Single SoC





# **FEATURES AND BENEFITS (continued)**

- On-chip EEPROM for storing factory and customer calibration parameters
	- □ Single-bit error correction, dual-bit error detection through the use of error correction control (ECC)
- Supports harsh operating conditions required for automotive and industrial applications, including direct connection to 12 V battery
	- □ Operating temperature range from –40°C to 150°C
	- $\Box$  Operating supply voltage range from 4.0 to 16.5 V ♦Can support ISO 7637-2 Pulse 5b up to 39 V
- Multiple output formats supported for ease of system integration
	- □ ABI/UVW output provides high resolution, low latency, and PWM for initial position
	- $\Box$  10 MHz SPI for low latency angle and diagnostic information; enables multiple independent ICs to be connected to the same bus
	- □ Output resolution on ABI and UVW are selectable
- Multiple programming / configuration formats supported □ The system can be completely controlled and programmed
	- over SPI, including EEPROM writes □ For system with limited pins available, writing and reading can be performed over VCC and PWM pins. This allows configuring the EEPROM in production line for a device with only ABI/UVW and PWM pins connected.
- Stacked dual die construction to improve die-to-die matching for systems that require redundant sensors
- Reduces magnet misalignment impact on die-to-die matching for a given magnet diameter, relative to "side-by-side" dual die orientation





### **ABSOLUTE MAXIMUM RATINGS**



[1] Maximum operational voltage is reduced at high ambient temperatures  $(T_A)$ . See Operating Characteristics, footnote 2.

#### **THERMAL CHARACTERISTICS:** May require derating at maximum conditions; see application information



[2] Additional thermal information available on the Allegro website.



# **Table of Contents**









**Figure 2: Typical Application Circuit** 

Both die are electrically separate, and may be operated simultaneously using different Power/GND sources.

# **PINOUT DIAGRAMS AND TERMINAL LIST TABLES**

**Pinout Diagram**

### **LE 14-Pin TSSOP Terminal List Table**







### **Pinout Diagram**



#### **LP 24-Pin eTSSOP Terminal List Table**





### **OPERATING CHARACTERISTICS:** Valid over the full operating voltage and ambient temperature ranges, unless otherwise noted



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#### **OPERATING CHARACTERISTICS (continued):** Valid over the full operating voltage and ambient temperature ranges, unless otherwise noted



#### $[1]$  1 G (gauss) = 0.1 mT (millitesla).

[2] Maximum operational voltage is reduced at high ambient temperatures  $(T<sub>A</sub>)$ . See plots below.



[3] Undervoltage flag indicates V $_{\rm CC}$  level below expected operational range. Degraded sensor accuracy may result.

[4] During the power-on phase, the A1339 SPI transactions will be valid within ≈ 300 µs of power on (with no self-tests). Angle reading requires full t<sub>PO</sub> to stabilize.

[5] Parameter is not guaranteed at final test. Determined by design.

<sup>[6]</sup> The output voltage specification is to aid in PCB design. The pin is not intended to drive any external circuitry. The specifications indicate the peak capacitor charging and discharging currents to be expected during normal operation.

[7] Tested at wafer probe only.

 $^{[8]}$  RES<sub>ANGLE</sub> represents the number of bits of data available for reading from the die registers.

[9] The rate at which a new angle reading will be ready.

[10] This value represents 3-sigma or three times the standard deviation of the measured samples.

[11] Effective Resolution is calculated using the formula below:

$$
log_2(360) - log_2\left(\frac{1}{n}\sum_{i=1}^n \sigma_i\right)
$$

where σ is the Standard Deviation based on thirty averaged measurements taken at each of the 32 angular positions, I = 11.25, 22.5, ... 360. [12] Maximum observed angle drift following AEC-Q100 stress was 1.37 degrees.





**TYPICAL PERFORMANCE CHARACTERISTICS**

**Figure 3: Peak Angle Error over Temperature [1] (300 G)**



**Figure 5: Peak Angle Error Distributions over Temperature (300 G)**



**Figure 4: Maximum Absolute Drift from 25°C Reading [1] (300 G)**



[1] Central mark indicates median value. Bottom and top edges of the box indicate the 25th and 75th percentiles. Whiskers extend to the most extreme data points not defined as outliers. Outliers are shown in red. Outliers are defined as those points outside Q1 or Q3 by more than 1.5 times the interquartile range (≈ 2.7σ away from the center of the distribution).









**Figure 11: Average Angle Error over Temperature Across 10 Devices. Recommended operating range: 300 G and above.**





**Recommended operating range: 300 G and above.**







**Recommended operating range: 300 G and above.**



**Figure 14: Average 3 Sigma Angle Noise over Field.** 

**Recommended operating range: 300 G and above.**





**Figure 15: Average Angle Drift over Temperature Across 10 Devices.** 

**Recommended operating range: 300 G and above.**



**Figure 16: Average Angle Drift over Field Across 10 Devices.** 

**Recommended operating range: 300 G and above.**



# **FUNCTIONAL DESCRIPTION**

### **Overview**

The A1339 is a rotary position Hall-sensor-based device in a surface-mount package, providing solid-state consistency, reliability, and supporting a wide variety of automotive applications. The Hall-sensor-based device measures the direction of the magnetic field vector through 360° in the x-y plane (parallel to the branded face of the device) and computes an angle measurement based on the actual physical reading, as well as any internal parameters that have been set by the user. The output is used by the host microcontroller to provide a single channel of target data.

This device is an advanced, programmable system-on-chip (SoC). Each integrated circuit includes a Circular Vertical Hall (CVH) analog front end, a high-speed sampling A-to-D converter, digital filtering, digital signal processing (which includes two separate signal paths), SPI, PWM, motor commutation outputs (UVW), and encoder outputs (A, B, I).

Offset, filtering, and diagnostic adjustment options are available in the A1339. These options can be configured in onboard EEPROM, providing a wide range of sensing solutions in the same device. Device performance can be optimized by enabling individual functions or disabling them in EEPROM to minimize latency.

## **Angle Measurement**

The IC features two digital signal paths. The main signal path uses a PLL to generate high resolution, low latency angle readings. A secondary, lower power signal path (referred to as the "ZCD path") is used for turns counting, magnetic field measurement, and diagnostic comparison.

The A1339 is capable of tracking magnet position at high speed. Performance up to 12,000 rpm has been verified by testing. Operation up to 30,000 rpm has been verified via design simulation.

The A1339 has a typical refresh rate of 1 MHz.

Angle is represented as either a 12- or 15-bit value, based on the register address accessed.

### **12 Bit Angle Value; Serial register 0x20**



### **15 Bit Angle Value; Serial Register 0x32**



When reading the 12-bit angle value, 3 additional status bits are provided with each packet: a general error flag (EF), undervoltage flag (UV), and a parity bit (P).

PWM output is always resolved to a 12-bit angle value. ABI/ UVW operates on a 15-bit angle representation.

The zero degree position may be adjusted by writing to EEPROM.

The sensor readout is processed in various steps. These are detailed in Figure 21.

# **System Level Timing**

Internal registers are updated with a new angle value every  $t_{\text{ANG}}$ . Due to signal path delay, the angle is  $t_{\text{RESPONSE}}$  old at each update. In other words, tRESPONSE is the delay from time of magnet sampling until generation of a processed angle value. SPI, which is asynchronously clocked, results in a varying latency depending on sampling frequency and SCLK speed. The values which are presented to the user are latched on the first SCLK edge of the SPI response frame. This results in a variable age of the angle data, ranging from  $t_{RESPONSE} + t_{SPI}$  to  $t_{RESPONSE} + t_{ANG}$  $+$  t<sub>SPI</sub>, where t<sub>SPI</sub> is the length of a read response packet, and t<sub>ANG</sub> is the update rate of the angle register.

Similar to SPI, when using the PWM output, the output packet is not synchronized with the internal update rate of the sensor. The angle is latched at the beginning of the carrier frequency period (effectively at the rising edge of the PWM output). Because of this, the age of the angle value, once read by the system microcontroller, may be up to  $t_{RESPONSE} + t_{ANG} + 1/f_{PWM}$ .

Figure 20 shows the update rate and the signal delay of the different angle output paths depending on sensor settings.

The value of the "angle zcd" (low power signal path) register is updated approximately every 32 µs. The field strength reading (register 0x2A) is updated approximately every 128 µs.

# **Impact of High Speed Sensing**

Due to signal path latency, the angle information is delayed by  $t_{RESPONSE}$ . This delay equates to a greater angle value as the rotational velocity increases (i.e. a magnet rotating at 20,000 rpm traverses twice as much angular distance in a fixed time period as a magnet rotating at 10,000 rpm), and is referred to as angular lag.

The lag is directly proportional to rpm, and may be compensated for externally, if the velocity is known.



Angular lag can be expressed using the following equation:

$$
Ang\_Lag = \frac{rpm \times 6}{1,000,000} \times t_{RESPONSE}
$$

where *rpm* represents the rotational velocity of the magnet, *Angle\_Lag* is expressed in degrees, and *tRESPONSE* is in µs.

Figure 17 depicts the expected angular lag over rpm.



**Figure 17: Expected Angle Lag vs. RPM**

### **Measured Performance Over RPM**

Figure 18 and Figure 19 show the measured performance of the A1339 at speeds up to 12,000 rpm. Data taken with no internal averaging (ORATE =  $0$ ).

Figure 18 depicts the measured angle lag over increasing rpm. Data was collected by triggering SPI angle reads off a high precision encoder. To present data independent of output protocol, the delay due to SPI packet transmission has been removed from the plot. As such the plot shows the angle lag due to signal path delays only.

Figure 19 depicts the equivalent response time (in µs), derived from the slope of Figure 18. The measured response times ranges between 6.5 and 7.6 µs.







**Figure 19: Measured Response Time Over RPM**











**Figure 21: Angle Measurement – Sensor Readout Steps**  Names in quotes correspond to EEPROM or serial register fields.



## **Power-Up**

Upon applying power to the A1339, the device automatically runs through an initialization routine. The purpose of this initialization is to ensure that the device comes up in the same predictable operating condition every power cycle. This initialization routine takes time to complete, which is referred to as Power-On Time,  $t_{\text{PO}}$ . Regardless of the state of the device before a power cycle, the device will re-power with the shadow memory contents copied from the EEPROM anew, and serial registers in their default states. For example, on every power-up, the device will power with the "zero\_offset" that was stored in the EEPROM. The extended write access field "write adr" will be set back to its default value, zero.

## **PWM Output**

The A1339 provides a pulse-width-modulated open-drain output, with the duty cycle (DC) proportional to measured angle. The PWM duty cycle is clamped at 5% and 95% for diagnostics purposes. A 5% DC corresponds to 0°; a 95% DC corresponds to 360°.



#### **Figure 22: PWM Mode Outputs a Duty-Cycle Proportional To Sensed Angle**

Within each cycle, the output is high for the first 5% and low for the last 5% of the period. The middle 90% of the period is a linear interpolation of the angle as sampled the start of the PWM period.



### **Figure 23: Pulse-Width Modulation (PWM) Examples**

The angle is represented in 12-bit resolution and can never reach 360°. The maximum duty cycle high period is:

DutyCycleMax (%) =  $(4095 / 4096) \times 90 + 5$ .

### **PWM CARRIER FREQUENCY**

The PWM carrier frequency is controlled via two EEPROM fields, both of which are found in the PWS row.

- PWM\_FREQ
- PWM\_BAND

Together, these two fields allow 128 different PWM carrier frequencies to be selected.

### **Table 1: PWM Carrier Frequencies in Hz**





### **Incremental Output Interface (ABI)**

The A1339 offers an incremental output mode in the form of quadrature A/B and Index outputs to emulate an optical or mechanical encoder. The A and B signals toggle with a 50% duty cycle (relative to angular distance, not necessarily time) at a frequency of 2N cycles per magnetic revolution, giving a cycle resolution of  $(360/2<sup>N</sup>)$  degrees per cycle, where N is set by the resolution\_pairs field in EEPROM; see Table 2. B is offset from A by ¼ of the cycle period. The "I" signal is an index pulse that occurs once per revolution to mark the zero (0) angle position. One revolution is shown below:





Since A and B are offset by ¼ of a cycle, they are in *quadrature* and together have four unique states per cycle. Each state represents R =  $[360 \div (4 \times 2^N)]$  degrees of the full revolution. This angular distance is the quadrature resolution of the encoder. The order in which the states change, or the order of the edge transitions from A to B, allow the direction of rotation to be determined. If a given B edge (rising/falling) precedes the following A edge, the angle is increasing from the perspective of the electrical (sensor) angle and the angle position should be incremented by the quadrature resolution (R) at each state transition. Conversely, if a given A edge precedes the following B edge, the angle is decreasing from the perspective of the electrical (sensor) angle and the angle position should be decremented by the quadrature resolution (R) at each state transition. The angle position accumulator wraps each revolution back to 0.

The quadrature states are designated as Q1 through Q4 in the following diagrams, and are defined as follows:



Note that the A/B progression is a grey coding sequence where only one signal transitions at a time. The state progression must be as follows to be valid:

Increasing angle:  $Q1 \rightarrow Q2 \rightarrow Q3 \rightarrow Q4 \rightarrow Q1 \rightarrow Q2 \rightarrow Q3 \rightarrow Q4$ Decreasing angle:  $Q4 \rightarrow Q3 \rightarrow Q2 \rightarrow Q1 \rightarrow Q4 \rightarrow Q3 \rightarrow Q2 \rightarrow Q1$ 



The duration of one cycle is referred to as 360 *electrical degrees*, or 360e. One half of a cycle is therefore 180e and one quarter of a cycle (one quadrature state, or R degrees) is 90e. This is the terminology used to express variance from perfect signal behavior. Ideally the A and B cycle would be as shown below for a constant velocity:



**Figure 25: Electrical Cycle**

In reality, the edge rate of the A and B signals, and the switching threshold of the receiver I/Os, will affect the quadrature periods:



**Figure 26: Electrical Cycle**

Here, an exaggeration of the switching thresholds shows that Q4 and Q2, which are fall-fall and rise-rise, have the expected 90e period, whereas Q1 is less than expected and Q3 is greater than expected due to imbalance in switching thresholds.



### **ABI RESOLUTION**

**ABI INVERSION**

The A1339 supports the following ABI output resolutions. This is set via the "resolution pairs" field in EEPROM and shadow (EEPROM 0x19, bits 3:0).

### The logic levels of the ABI pins may inverted by setting the ABI.inv bit within EEPROM. This also applies if using the UVW output logic.

#### **Table 2: ABI Output Resolution**





### **INDEX PULSE**

The index pulse I (or Z in some descriptions) marks the absolute zero (0) position of the encoder. Under rotation, this allows the receiver to synchronize to a known mechanical/magnetic position, and then use the incremental A/B signals to keep track of the absolute position. To support a range of ABI receivers, the 'I' pulse has four widths, defined by the INDEX MODE EEPROM field, as shown below:





#### **ABI BEHAVIOR AT POWER-UP**

At power-up, the A1339 requires time to acquire a stable angle value; this is quantified by  $t_{PO}$  (or  $t_{PO}$  D, if power-on diagnostics are used). Because the angle value is not guaranteed to be stable between power-on and  $t_{PO}$ , the output of the ABI should be ignored until at least  $t_{PO}$  after power-on.



**Figure 28: ABI Startup Behavior**



### **ZERO DEGREE POSITION INDICATION**

The edge of the index pulse corresponding to the "Zero" position, as observed by the sensor, will change based on rotation direction, as shown in Figure 29.

With the magnet rotating such that the observed angle is increasing, the 0° position will be indicated by the rising edge of the Index pulse. If the magnet is rotated in the opposite direction (or the RO bit is changed in EEPROM) to produce a decreasing angle value, the 0° position will be represented by the falling edge of the Index pulse.

The ABI resolution and I pulse mode selection (described above) determine the width of the Index pulse and the corresponding shift in zero position indication.



**Figure 29: Index Pulse Corresponding to "Zero" Position**



#### **SLEW RATE LIMITING FOR ABI**

Slew rate limiting is enabled when the "abi\_slew\_time" field is non-zero. This option separates the sensor's observed angle change from the ABI output rate, and can be used to control two circumstances:

- The angle sample does not monotonically increase or decrease at the quadrature resolution, thereby "skipping" one or more quadrature states. In this case, the slew rate limiting logic transitions the ABI signals in the required valid sequence, at the slew rate, until the ABI output "catches up" with the angle samples, at which point the normal sample rate output resumes. This skipping will most likely occur either at very low velocities, if the noise is high, or at very high velocities when the angle changes more than the quadrature resolution in one angle sample period.
- The ABI receiver at the host end cannot reliably detect edge transitions that are spaced at the sample rate of 1 µs. The slew limit time can be set greater than the nominal angle sample update period, providing the velocity of the angle rotation would not on average require ABI transitions greater than the angle sample rate.

In both cases, the ABI output will correctly track the rotation position; however, the speed of the ABI edges will be accomplished at the slew rate limit set in EEPROM. Whenever slew rate limiting occurs, the SRW flag in the WARN serial register will assert informing the system of the occurrence.



**Figure 30: Slew Rate Limiting**

### **EFFECTIVE SPEED OF SLEW TIME**

When slew rate limiting occurs, the ABI update rate is no longer dependent on the observed rotation rate, but instead occurs at a period set via EEPROM. This change in the edge rate will be observed as a change in the target velocity. This perceived velocity depends on:

- The configured "abi\_slew\_time" (EEPROM 0x19 bits 21:16)
- The ABI resolution ("resolution pairs" EEPROM 0x19 bits 3:0)

Table 3 shows the equivalent RPMs for select combinations of slew time and ABI resolution.

When designing a system, it is important to note these RPMs will occur for any change in rotation direction (i.e. motor transitioning from CW to CCW rotation), when both hysteresis and ABI slew rate limiting are enabled, as the IC "back fills" the ABI edges for the programmed hysteresis window (EEPROM 0x17 bits 17:12).

#### **Table 3**





## **Brushless DC Motor Output (UVW)**

The A1339 offers U, V, and W signals for commutation of brushless DC (BLDC) motors. If hysteresis is enabled (set via "ahe", bit 12 of EEPROM address 0x19), the UVW edges will update based off the rotation direction and hysteresis window. See the Hysteresis section of this document for greater detail. The U, V, and W outputs switch when the measured mechanical angle

crosses the value where a change should occur. By default, the UVW signals are 180° duty cycle waveforms (complete one cycle every 360°), spaced 120° apart. Options are provided for 1 to 16 pole-pairs, which control how many times the UVW waveforms are repeated for an observed mechanical rotation. This emulates the typical Hall switch output, from a multi pole-pair motor. Figure 32 and Figure 33 below show the UVW waveforms for three and five pole-pair BLDC motors.



**Figure 33: U, V, W Outputs for Five Pole-Pair BLDC Motor**





#### **Table 4: UVW Pole Pair Settings**



## **Angle Hysteresis**

Hysteresis can be applied to the compensated angle to moderate jitter in the angle output due to noise or mechanical vibration. In the A1339, the hysteresis field (ANG.hysteresis) defines the width of an angle window at 14-bit resolution. Mathematically, the width of this window is:

*HYSTERESIS* × (360 / 16384) degrees

HYSTERESIS is a 6-bit wide EEPROM field, allowing a range of 0 to 1.384 degrees of hysteresis to be applied.

The hysteresis-compensated angle can be routed to the ABI or UVW interface by setting the AHE bit in EEPROM to a 1 (bit 12 of address 0x19). On the SPI or Manchester interface, the hysteresis-compensated angle can be read via an alternate register (HANG.angle\_hys) at 12-bit resolution.

The effect of the hysteresis is shown in Figure 34. The current angle position as measured by the sensor is at the "head" of the hysteresis window. As long as the sensor (electrical) angle advances in the same direction of rotation, the output angle will be the sensor angle, minimizing latency. If the sensor angle reverses direction, the output angle is held static until the sensor angle exits the hysteresis window in either direction. If the exit is in the opposite direction of rotation where the "head" was, the head flips to the opposite end of the hysteresis window and that becomes the new reference direction. The current direction of rotation, or "head" for the purposes of hysteresis, is viewable via the STA.rot bit, where 0 is increasing angle direction and 1 is in decreasing angle direction.

This behavior has the following consequences:

- 1. If the hysteresis window is greater than the output resolution, the output angle will skip consecutive resolution steps.
- 2. If there is jitter due to noise or mechanical vibration, especially at a static angle position or very slow rotation, the angle will tend to bias to one side of the window, depending on the direction of rotation as the angular velocity approaches zero (i.e., towards the current "head") rather than to the average position of the jitter.



Sensor angle position Window of hysteresis Sensor angle and output angle the same Output angle Direction of rotation as seen by the hysteresis logic



### **Figure 34: Effect of Hysteresis**

Note: The rotation direction resets to 0, or increasing angle direction. At power-up or exiting low power mode, or after LBIST, the hysteresis window will always be behind the initial angle position, so if hysteresis is enabled a decreasing angle direction of rotation will not register until the hysteresis window is past.



## **Low Power Mode**

Low Power Mode (LPM) is an automatic duty cycling between a reduced-power angle sampling "wake" state and a minimal power "sleep" state. Low power mode is only entered if a set of conditions is met (this is shown graphically in Figure 36):

- The SPI pins have to be low, AND
- The change of the magnetic field angle has to be below the programmed threshold, AND
- The WAKE pin voltage must be below the WAKE pin falling threshold, AND
- Low Power Mode is enabled

In Low Power Mode (LPM), the IC does not provide normal angle readings via the IOs. The PWM output will be held high (via the external pull-up), the MISO and A/B/I (UVW) pins will tri-state, the majority of the analog and digital circuitry are powered down, and the sensor IC periodically cycles between two different states. For most of the time, the sensor IC is held in a lower power quiescent current "sleep" state ( $I_{CC} \approx 75 \mu A$ ). In this state, power is removed from the analog transducer and no angle measurements take place.

Periodically, the sensor IC will enter an "awake" state to monitor the magnet position via a reduced power signal path and update the turns count ( $I_{CC} \approx 8 \text{ mA}$ ). The sleep time of the Low Power Mode operation can be adjusted by the user, based on the application, by programming on-chip EEPROM memory.

In case the change of angle between successive samples is larger than a set threshold, the sensor will stay in its "wake" state to prevent missing a potential rotation.

### **STATE TRANSITIONS WITHIN LOW POWER MODE**

The SPI input pins are used as the primary arbiter of low power mode. When all three pins inputs (MOSI, SCLK, CSN) are pulled low for at least 64 µs, the sensor enters a semi-low power state in which the PLL and some other logic are disabled (including SPI and Manchester), the I/O regulator is turned off, and the PWM pin is tristate. Only the low power angle sensing path is enabled in order to update the turns counter and measure angular velocity.

This state is called the "wake" state.

In the "wake" state, the velocity and WAKE pin are monitored. Once the velocity is below the threshold set in the EEPROM and the WAKE pin is below the low threshold level, the sensor enters "sleep". The low frequency oscillator remains on, with a counter for the sleep period ("lpm\_cycle\_time") and logic to detect SPI/WAKE pin going high active. Expiration of the counter or assertion of the WAKE pin signal transitions the sensor from the "sleep" state to the "wake" state to update the turns counter and measure the velocity based on change in angle from the previous "wake" state. If the velocity exceeds the threshold, the sensor remains awake and updating the turns counter.

The SPI pins must change from their all-zeros state to resume normal mode operation; this will be followed by a settle time for the PLL to lock before angle output and temperature update is resumed.

All decisions about entering the "sleep" state are made at the end of the "lpm\_cycle\_time", which runs continuously no matter what state the sensor is in. Therefore the sensor only can enter "sleep" on those time boundaries.

### **AVERAGE CURRENT CONSUMPTION IN LPM**

Assuming the sensor is moving between the two LPM states in a periodic manner, the effective current draw observed from the system is the average of the two different current consumptions, weighted by the time of each state.

$$
I_{\rm CC(AVG1p)} = \frac{t_{\rm LPsleep}}{t_{\rm total}} \times I_{\rm LPsleep} + \frac{t_{\rm LPvake}}{t_{\rm total}} \times I_{\rm LPvake}
$$

 $t_{\text{L}}$ <sub>Ps</sub>l<sub>eep</sub>

where:

$$
t_{total} = t_{LPsleep} + t_{LPwake}
$$

$$
t_{LPwake} = 160 \,\mu s
$$

The wake state time ( $t_{LPwake}$ ) is fixed by Allegro at 160  $\mu$ s (typical value). This is the amount of time the sensor requires to take an accurate "snapshot" of the magnetic position.

The amount of time the sensor spends in "sleep" mode is programmable via EEPROM, between 8.192 and 524 ms.

Figure 35 depicts the typical LPM  $I_{CC}$  over different Sleep times.





Figure 35: Typical Average Low Power Mode Current Consumption;  $T_A = 25^{\circ}$ C, V<sub>CC</sub> = 16 V









 $SCK < VIL$  for 64  $\mu s$ , AND  $\overline{\text{CS}}$  < VIL for 64 µs, AND MOSI < VIL for 64 µs, AND "special" code for transport mode *is* set  $SCK > V/L$ , OR  $\overline{\mathsf{CS}}$  > $\not$ //IL, or  $MOSI > VIL$ speed < 100 RPM AND SCK, CS, MOSI < VIL ( $(400 \text{ ms}$  timer expired) AND SCK, <del>CS</del>, MOSI < VIL  $SCK, \overline{CS}, MOSI < VIL$ AND ( ( speed > 100 RPM ) OR (WAKE pin > threshold) ) SCK > VIL, OR<br>CS > VIL, OR<br>MOSI > VIL SCK > VIL, OR<br>CS > VIL, OR<br>MOSI > VIL Low power mode "Sleep" state "Wake" state Full power mode Power-on reset **Transport** mode "special" code for transport mode not set, ANQ SCK < VIL for 64 μs, AND<br>CS < VIL for 64 μs, AND MOSI < VIL for 64 µs OR (WAKE pin > threshold) )

When using the default settings, the diagram can be simplified to the one below (Figure 37):

**Figure 37: Simplified Low Power Flowchart, Default Settings** 



### **WAKE Pin**

The A1339 also offers a WAKE input pin. This pin is intended to bring the sensor out of its sleep state in the special case where the motor acceleration is too high and the system cannot afford to wait for the entire Sleep time to expire. This is illustrated in Figure 36 and Figure 37. When the voltage threshold on the WAKE pin exceeds V<sub>WAKE(HITH)</sub>, the IC will enter the "wake" state of LPM and track turns. It is important to emphasize that during this state (with the

WAKE pin high) the sensor is kept in the "Wake" state of LPM. The IC does not produce angles, but instead tracks turns at a faster rate than otherwise would be accomplished during typical LPM operation (i.e. alternating between Sleep and WAKE states). This pin is usually connected to a filtered version of the back-EMF voltage signal from the motor being used. This allows fast feedback from the motor to the Turns-Count circuit, in the case of high acceleration events. A symbolic waveform representation of the back EMF for a Star 3-phase motor, as well as a sample filtering circuit, are shown below.



Back-EMF Frequency and Amplitude *α* motor RPM. (Motor BEMF frequency and amplitude are both proportional to motor RPM.)





**Figure 39: Sample Filtering Circuit**









The A1339 features a programmable threshold and programmable hysteresis for the the WAKE pin. Rising and corresponding falling thresholds are set via the WP\_HYS and WP\_THRES fields in EEPROM. The following table provides a list of combinations.



#### **Table 5: Nominal WAKE Pin Threshold Levels**



### **Turns Counting and Low Power Mode**

Certain automotive angle sensing applications require the ability to track angular position, even in key-off conditions. In the key-off state, most voltage regulators in the vehicle are not operational. Therefore, sensors that must operate in the key-off state are often powered directly from the car battery (12 V). Examples of such applications include:

- Seat-belt passive safety systems
- EPS motor position

Often, these motor and seat-belt systems are geared down so that multiple angle sensor rotations need to be counted by the angle sensor IC. For this reason, the A1339 includes a circuit that counts the rotational turns of a magnet. When sensor ICs are connected to the car battery, they must also have low-power modes that enable efficient battery usage. Very often, a sensor IC must track the turns-count (TCs) of the magnet even when the vehicle is in the key-off state. The A1339 monitors and keeps track of TCs, even when set to Low Power Mode. This will ensure that the system can accurately and consistently track steering wheel position or seat-belt extension when using the A1339 in a key-on or key-off mode. Traditionally, this key-off requirement is achieved by a combination of relatively complex mechanical and electronic components. The A1339 can reduce system-level complexity and eliminate many system components by performing both the absolute angle measurement and the tracking of TCs, while maintaining low battery power consumption at vehicle key-off.

The A1339 uses a low power signal path measurement to determine and keep track of turns counts, to within the specified Turns Count resolution. The design minimizes the amount of logic that is drawing power during the low-power awake periods, allowing for efficient turns count tracking during battery-operated low-power modes. The turns counter logic tracks the turns in either 45 or 180 degree increments, based on the T45 register field. Due to its emphasis on low power, the signal path which tracks total turns does not implement the same angle compensation as the primary signal path. Because of this, the turns count value will not precisely match the primary angle output.

The turns counter saturates at +2047 and –2048 in the 45-degree mode and +511 and –512 in the 180-degree mode. If this happens, the Turns Count Warning Flag (bit 0 of serial register 0x26) will assert and stay asserted until the turns counter is reset via the Control register (serial register 0x1E). (see Primary Serial Interface Registers Reference section).

During Low Power mode, the A1339 periodically measures the magnet position, and updates the turns count based off the angular change from the previous angle measurement. If the angle changes by  $\geq$ 180 degrees, the direction change is ambiguous and will be interpreted as a rotation in the opposite direction. Any sample-to-sample delta greater than 135 degrees will set the Turns Count Warning Flag (serial register 0x26, bit 3). This is intended to give some indication relative to the low-power mode cycle time as to whether the velocity is high enough over that sleep period for the angle delta to be getting close to the 180 point of ambiguity.



**Figure 41: Example of a Turns Counting Application**



### **INVOKING A TURNS COUNTER RESET**

Resetting the turns counter is a command invoked using the "special" field of the CTRL register (Register address 0x1E, see Primary Serial Interface Reference). Following a reset, turns are tracked relative to that point, as measured by the LPM signal path (ZCD).

### **Transport Mode**

Transport mode is effectively "sleep" mode, but with the low frequency oscillator disabled such that no turns counting occurs. To invoke transport mode, the serial CTRL.special field is set to 6. Then when low power mode is enabled (SPI inputs 0 for > 64 μs), transport mode is entered. As soon as one of the incoming SPI lines is high, the A1339 will wake up again. Transport mode can be disabled using the customer EEPROM setting "tpmd".


# **DEVICE PROGRAMMING INTERFACES**

The A1339 can be programmed in two ways:

- Using the *SPI interface* for input and output, while supplying the VCC pin with normal operating voltage
- Using a *Manchester protocol* on the supply pin for input, and the PWM pin for output.

The A1339 does not require special supply voltages to write to the EEPROM.

All setting fields and all data fields of the sensor can be read and written using both protocols. If EEPROM locking is used (detailed in EEPROM lock section), then write access using either of the protocols will be prevented.

A separate setting to completely disable the Manchester interface is available in the dm field of the EEPROM. Using this setting will cause the sensor to ignore any commands entered using Manchester protocol. The SPI interface will not be disabled by disabling the Manchester interface.

# **Interface Structure**

The A1339 consists of two memory blocks: Primary serial registers, and extended memory (shadow and EEPROM). The primary serial interface registers are used for direct writes and reads by the host controller for frequently required information (for example, angle data, warning flags, field strength, and temperature). All forms of communication (even to the extended locations) operate through the primary registers, whether it be via SPI or Manchester.

The primary serial registers also provide a data and address loca-

tion for accessing extended memory locations. Accessing these extended location is done in an indirect fashion: the controller writes into the primary interface to give a command to the sensor to access the extended locations. The read/write is executed and the result is again presented in the primary interface.

This concept is shown in Figure 42 below.

For writing extended locations, the primary interface offers the registers "ewcs", "ewa", "ewdh", and "ewdl". "ewa" holds the extended address that should be written, and "ewdh" / "ewdl" contain the two high bytes and the two low bytes for the extended location contents. The "ewcs" register is used for commands and status information. Refer to the section "Read Transaction from EEPROM" for further information and other register fields associated with read transactions.

For reading extended locations, the primary interface offers the registers "ercs", "era", "erdh", and "erdl". "era" holds the extended address the should be read, and "erdh" / "erdl" contain the two high bytes and the two low bytes for the extended location contents. The "ercs" register is used for commands and status information. Refer to the section "Read Transaction from EEPROM" for further information and other register fields associated with read transactions.

EEPROM writing requires additional procedures. For more information on EEPROM and shadow memory read and write access, see EEPROM and Shadow Memory section.

The primary serial interface can be accessed using the SPI and using the Manchester interface. These two interfaces are detailed in the following sections.

<b>User</b> SPI / Manchester IF		<b>Primary Serial Interface</b>		<b>Extended locations</b>		
		Address Function			Shadow   EEPROM	Name
	02:03	<b>Extended Write Address</b>	Write data	address	address	
	04:05	Extended Write Data High			0x17	CU <sub>2</sub>
	06:07	<b>Extended Write Data Low</b>		0x58	0x18	<b>PWE</b>
	08:09	<b>Extended Write Control/Status</b>		0x59	0x19	ABI
	OA:OB	<b>Extended Read Address</b>		0x60	0x20	<b>MSK</b>
	OC:OD	Extended Read Control/Status		0x61	0x21	PWI
	OE:OF	Extended Read Data High	Read data	$\cdots$		
	10:11	<b>Extended Read Data Low</b>				$\cdots$
	1E:1F	Device Control				
	20:21	Angle				
	$\cdots$	$\cdots$				
	$\cdots$					

**Figure 42: Serial Registers allow access to extended memory (EEPROM and Shadow)**



# **SPI Interface**

The A1339 provides a full-duplex 4-pin SPI interface for each die, using SPI mode 3 (CPHA = 1, CPOL = 1). All programming can be done using this interface, but all programming can also be done using the Manchester interface.

In addition to providing a communications interface, the SPI interface is also used to control entering and leaving of the low power and transport modes. If the SPI interface is not used, do not leave the chip select line floating but instead follow the recommendations in the "Typical Application Diagram" section.

The sensor responds to commands received on the MOSI (Master-Out Slave-In), SCLK (Serial Clock), and CSB (Chip Select) pins, and outputs data on the MISO (Master-In Slave-Out) pin. All three input pins are 3.3 V and 5 V SPI compatible, with threshold values determined by factory EEPROM settings. MISO output voltage level will conform to 3.3 V or 5 V SPI levels, based on factory settings. Regular part are shipped with 3.3 V interface. Contact Allegro for ordering options of the 5 V variant.

The setup for communication using the SPI interface is given below.



**Figure 43: SPI Interface Programming Setup**

# **TIMING**

The interface timing parameters from the specification table are defined in the figures below.



**Figure 44: SPI Interface Timings Input**



**Figure 45: SPI Interface Timings Output**

## **SPURIOUS INTERFACE ERROR (IER) WHEN SHARING SPI LINES**

The IER error flag may provide an erroneous indication when the SCLK line is shared amongst multiple ICs. Ways to avoid this are detailed in Appendix B.





[1] Parameter is not guaranteed at final test. Determined by design.



### **MESSAGE FRAME SIZE**

The SPI interface requires either 16, 17, or 20-bit packet lengths. An extended 20-bit SPI packet allows 4 bits of CRC to accompany every data packet. A 17-bit packet is only allowed if the EEPROM/Shadow bit "s17" (bit 1 of EEPROM 0x1B) is set to 1.



#### **Figure 48: Twenty Bit SPI Transaction**

If more clock pulses than expected were detected by the sensor in an SPI transaction, the interface warning "warn.ier" will activate. This warning will not activate on clean SPI transactions with 16 or 20 bit, or with clean 17-bit transactions when "s17" is enabled.

The purpose of the 17-bit SPI option is to allow delayed reading of the MISO line by the host. Some host allow to sample data from the slave not on the rising edge, but on the next falling edge of SCLK. This way, in case of long interface delays caused by large line capacitance or very long cables, the permissible clock speed can be increased. However, a 17th falling edge is required to read the 16th bit coming from the sensor. For the sensor to not display an error when this 17th clock is found, the bit "s17" must be set.

### **21-BIT SPI PACKET**

If sharing an SPI bus, the A1339 may exhibit a false IER flag when using the standard SPI packet sizes. To prevent this, a 21-bit SPI packet should be used.



### **Figure 49: Twenty-One Bit SPI Transaction**

The 21<sup>st</sup> bit sent from the master should be a logic '0', effectively left-shifting the standard 20-bit packet by 1 bit. The IC's response will repeat the most significant bit of the CRC, shifted out on the last SCLK edge. See Appendix B for more information.

### **WRITE CYCLE**

Write cycles consist of a 1-bit low, a 1-bit  $R/W$  (write = high), 6 address bits (corresponding to the primary serial register), 8 data bits, and 4 optional CRC bits. To write a full 16-bit serial register, two write commands are required (even and odd byte addresses). MOSI bits are clocked in on the rising edge of the Master-generated SCLK signal.

### **READ CYCLE**

Reading data always involves at least two SPI frames. In the first frame, the read command is sent, while in the second frame, the result from the first read is received. While receiving data from the last read command, it is possible to send another read command (duplexed read). This way, every frame except the first one contains data from the sensor. This is useful for very fast reading of angle information.

When receiving the last frame, the host can transmit a command with MOSI set to all zeros. This represents a read command from register 0x00 and will not cause any reaction from the sensor. Reading from register 0x00 will output the value 0x0000.

In frames where no previous read command was sent, the MISO data output should be ignored.



Because an SPI read command can transmit 16 data bits at one time, and the primary serial registers are built from one even and one odd byte, the entire 16-bit contents of one serial register may be transmitted with one SPI frame. This is accomplished by providing an even serial address value. If an odd value address is sent, only the contents of the single byte will be returned, with the eight most significant bits within the SPI packet set to zero. Example: To read all 16 bits of the error register (0x24:0x25), an SPI read request using address 0x24 should be sent. If only the 8 LSBs are desired, the address 0x25 should be used. Figure 50 shows examples of both an SPI write and an SPI read request, using a 16-bit SPI message frame.



**Figure 50: SPI Read and Write Pulse Sequences**



# **CRC**

If the user want to check the data coming from the sensor, it is possible to use 20-bit SPI frames. Without additional setting required, a 4-bit CRC is automatically generated and placed on the MISO line if more than 16 bits are read from the sensor.

The four additional CRC bits on the MOSI line coming from the host are ignored by the sensor, unless the "PWI.sc" bit is set within EEPROM (0x1B, bit 0). When the incoming CRC check is enabled, an incoming SPI packet with an incorrect CRC will be discarded, and the CRC error flag set in serial register "warn.crc".

The CRC is based on the polynomial  $x^4 + x + 1$  with the linear feedback shift register preset to all 1s. The 16-bit packet is shifted through from bit 15 (MSB) to bit 0 (LSB). The CRC logic is shown in Figure 51. Data are fed into the CRC logic with MSB first. Output is sent as C3-C2-C1-C0.



## **Figure 51: SPI CRC**

The CRC output by the sensor on the MISO pin will always be correct. The CRC from the host on the MOSI pin must be correct if the CRC enable bit PWI.sc in the EEPROM was set.

Note: If the ERD (extended read data) register is read before the "ERCS.ERD" bit indicates a read has completed, there is a possibility of a CRC error, as the data could change during the read. Do not read the ERD register until it is known to be stable based on the done bit indication or waiting sufficient time.

The CRC can be calculated with the following C code:

```
/*
* CalculateCRC
*
* Take the 16-bit input and generate a 4-bit CRC
* Polynomial = x^4 + x + 1
* LFSR preset to all 1's
*/
uint8_t CalculateCRC(uint16_t input)
{
     bool CRC0 = true;
     bool CRC1 = true;
     bool CRC2 = true;
    bool CRC3 = true; int i;
     bool DoInvert;
     uint16_t mask = 0x8000;
    for (i = 0; i < 16; ++i) {
        DoInvert = ((input & mask) != 0) ^ c CRC3;
        CRC3 = CRC2;CRC2 = CRC1; CRC1 = CRC0 ^ DoInvert;
         CRC0 = DoInvert;
        mask \gg = 1;
     }
```
 return (CRC3 ? 8U : 0U) + (CRC2 ? 4U : 0U) + (CRC1 ? 2U : 0U) + (CRC0 ? 1U : 0U); }



# **Manchester Interface**

To facilitate addressable device programming when using the unidirectional PWM, ABI or UVW protocols, without requiring four additional SPI connections, the A1339 incorporates a serial input on the VCC line and responds to read requests using the PWM line.

This interface allows an external controller to read and write registers in the A1339 EEPROM and volatile memory. The device uses a point-to-point communication protocol, based on Manchester encoding per G.E. Thomas (a rising edge indicates a 0 and a falling edge indicates a 1), with address and data transmitted MSB first. The addressable Manchester code implementation uses the logic states of the SA0/SA1 pins to set address values for each die. In this way, individual communication with up to four A1339 dies is possible. To prevent any undesired programming of the A1339, the serial interface can be disabled by setting the Disable Manchester bit, "PWI.dm", to 1. With this bit set, the sensor will ignore any Manchester input on VCC.

The setup for communication using the Manchester interface is given in Figure 52.



## **Figure 52: Manchester Interface Programming Setup**

# **CONCEPT OF MANCHESTER COMMUNICATION**

The Manchester interface allows programming and readout with a minimal number of pins involved. This is beneficial for sensor subassemblies connected to wiring harnesses, because less connections are needed. The supply level is typically modulated between 5 and 8 volts ( $V_{MAN(H)}$  and  $V_{MAN(L)}$ ) to produce a "low" and "high" signal. In the absence of a clock signal, Manchester encoding is used, allowing the sensor to determine the bit rate that the host is using.

The master can freely choose any supported Manchester communication frequency for each transaction. The sensor will recognize the transaction speed used by the master and send the response at the same data rate.

As Manchester commands are sent on the supply line, the speed is usually limited by capacitances on the supply line. A reduction of the bit rate, or using a stronger line driver, can help to ensure stable communication.

If a correct read command was sent, the sensor responds to the master using the open-drain output on the PWM line. The high level will be determined by the PWM pull-up (usually 3.3 V or 5 V), and the low level will be close to GND. The PWM uses an open drain output, setting the logic levels to GND and logic level high (see Figure 52). A sufficient pull-up resistor (e.g.  $4.7 \text{ k}\Omega$ ) must be used to pull the line to a maximum logic high level  $V_{IN}$ .

## **ENTERING MANCHESTER COMMUNICATION MODE**

Provided the Disable Manchester bit is not set in EEPROM, the A1339 continuously monitors the VCC line for valid Manchester commands. The part takes no action until a valid Manchester Access Code is received.

There are two special Manchester code commands used to activate or deactivate the serial interface and specify the output format used during Read operations:

- 1. Manchester Access Code: Enters Manchester Communication Mode; Manchester code output on the PWM pin. See further paragraphs for example.
- 2. Manchester Exit Code; returns the PWM pin to normal operation. See further paragraphs for example.

Once the Manchester Communication Mode is entered, the PWM output pin will cease to provide angle data, interrupting any data transmission in progress.

# **TRANSACTION TYPES**

The A1339 receives all commands via the VCC pin, and responds to Read commands via the PWM pin. This implementation of Manchester encoding requires the communication pulses be within a high ( $V_{MAN(H)}$ ) and low ( $V_{MAN(L)}$ ) range of voltages on the VCC line. Each transaction is initiated by a command from the controller; the sensor does not initiate any transactions. Two commands are recognized by the A1339: Write and Read.



### **CONTROLLER MANCHESTER MESSAGE STRUCTURE**

The general format of a command message frame is shown in Figure 53. Note that, in the Manchester coding used, a bit value of 1 is indicated by a falling edge within the bit boundary, and a bit value of zero is indicated by a rising edge within the bit boundary.



**Bit boundaries** 

**Figure 53: Manchester Message Format**

A brief description of each bit is provided in Table 7.

#### **Table 7: Manchester Command General Format**



When the A1339 is operating in PWM mode, the Die ID value is determined by the state of the CSN and MOSI pins, as detailed in Table 8.

#### **Table 8: Pin Values**



Using the 4 bits of the Chip Select field, die can be selected via their ID value, allowing up to four die to be individually addressed and providing for different group addressing schemes.

Example: If Target ID =  $[1 0 1 0]$ , all die with ID3 or ID1 will be selected. If Target ID is set to [0 0 0 0], then no ID comparison will be made, allowing all sensors to be addressed at once. In case of PWM line sharing for Manchester communication, reading must be done one die at a time.

#### **Table 9: Target ID**





### **SENSOR MANCHESTER MESSAGE STRUCTURE**

If a read command with the desired register number was sent from the controller to the sensor, the device responds with a Read Response frame using the Manchester protocol over the PWM output.

The following command messages can be exchanged between the device and the external controller:

- Manchester Access Code (host to sensor)
- Manchester Exit Code (host to sensor)
- Manchester Write Command (host to sensor)
- Manchester Read Command (host to sensor)
- Manchester Read Response (sensor to host)



**Figure 54: Manchester Message Format**

In addition to the contents of the requested memory location, a Return Status field is included with every Read Response. This field provides the ID used to communicate with the part and any errors which may have occurred during the transaction. These bits are:

- **ID** ID (CSN/MOSI) unless  $BC = 1$  (ID will be 00)
- **BC** Broadcast; ID field was zero or SPI mode active
- **AE** Abort Error; edge detection failure after sync detect
- **OR** Overrun Error; A new Manchester command has been received before the previous request could be completed
- **CS** Checksum error; a prior command had a checksum error

For EEPROM address information, refer to the EEPROM structure section. For serial address locations, refer to the serial register map.

#### **Table 10: Return Status Bits**



### **MANCHESTER ACCESS CODE**

The Manchester Access Code has to be sent before other Manchester commands.

The Manchester Access Code always operates as a broadcast pulse, meaning the sensor will not look at the Target ID field. For example, if two sensors configured with ID0 and ID1 respectively are sharing a common VCC line, a Manchester Access Code with a Target ID value of [0 0 1 0] results in both sensors entering Manchester Serial Communication mode.

#### **Table 11: Manchester Access Code**



An example is given below, with target  $ID = [0 0 0 1]$ , data = access code =  $0x62D2$ , and CRC = '110'.



**Figure 55: Target ID = [0 0 0 1], Data = Access code = 0x62D2, CRC = '110' 4.3.5.2**



## **MANCHESTER EXIT CODE**

The Manchester Exit Code can be sent after Manchester access is complete in order to avoid accidental decoding of Manchester commands.

The Manchester Exit Code always operates as a broadcast pulse, meaning the sensor will not look at the Target ID field. For example, if two sensors configured with ID0 and ID1 respectively are sharing a common VCC line, a Manchester Access Code with a Target ID value of [0 0 1 0] results in both sensors exiting Manchester Serial Communication mode.

#### **Table 12: Manchester Exit Code**



An example is given below, with target ID =  $[0 0 0 1]$ , data = 0x0000, and CRC =  $110$ .

### **0 0 0 0 0 0 1 1 1 1 1 1 1 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 1 1 0 0x00 0x00**



### **MANCHESTER READ COMMAND**

Determines the serial address within the sensor from which the next Read Response will transmit data. The sensor must first receive a Manchester Access Code before responding to a read command.

This command is sent by the controller.





An example is given below where register 0x20 "angle" is read from target ID  $[0\ 0\ 0\ 1]$  with CRC = '111'. The two sync pulses from the Read Response on the PWM return line are also shown.



**Figure 57: Target ID = [0 0 0 1], "angle" = 0x20, CRC = '111'**



## **MANCHESTER READ RESPONSE**

The read response transmits data from the sensor to the controller after a read command. These data are sent by the sensor on the open-drain PWM pin. A pull-up resistor is needed for this to work. Read from an even address returns even byte [15:8] and odd byte [7:0].

Read from an odd address returns odd byte [7:0] only. Data bits [15:8] will be zeroes.



### **Table 14: Manchester Read Response**

An example is given below where register  $0x20$  "angle" is read, and the response is ID '00' (ID0), the four flags are all zeros (no errors), the data is "0x5C34", and the CRC is '100'.



**0x5C 0x34 0 0 0 0 0 0 0 0 0 1 0 1 1 1 0 0 0 0 1 1 0 1 0 1 0 0 0**

Figure 58: ID = '00', error flag = '0000', Data = 0x5C34, CRC = '100'

### **MANCHESTER READ RESPONSE DELAY**

The Manchester Read Reponse starts at the end of the Read Command. The response may start a ¼ bit time before the CRC is finished transmitting (overlap with last CRC bit) or ¼ after the CRC finished transmitting.



## **CRC**

The serial Manchester interface uses a cyclic redundancy check (CRC) for data-bit error checking of all the bits coming after the two synchronization bits. The synchronization bits are not included in the CRC. The CRC algorithm is based on the polynomial:

$$
g(x) = x^3 + x + 1.
$$

The calculation is represented graphically in Figure 59. The trailing 3 bits of a message frame comprise the CRC token. The CRC is initialized at 111. Data are fed into the CRC logic with MSB first. Output is sent as C2-C1-C0.



**Figure 59: Manchester CRC Calculation**

The 3-bit Manchester CRC can be calculated using the following C code:

// command: the manchester command, right justified, does not include the space for the CRC // numberOfBits: number of bits in the command not including the 2 zero sync bits at the start of the command and the three CRC bits

// Returns: The three bit CRC

{

}

// This code can be tested at http://codepad.org/yqTKnfmD

uint16\_t ManchesterCRC(uint64\_t data, uint16\_t numberOfBits)

```
 bool C0 = false;
        bool C1 = false;
        bool C2 = false;
       bool C0p = true;
       bool C1p = true;bool C2p = true;uint64_t \text{ bitMask} = 1; bitMask <<= numberOfBits - 1;
        // Calculate the state machine
       for (; bitMask != 0; bitMask >>= 1)
        {
               C2 = C1p;C\theta = C2p ^ ((data & bitMask) != \theta);
               C1 = C0 \wedge C0p;
               C0p = C0;C1p = C1;C2p = C2; }
        return (C2 ? 4U : 0U) + (C1 ? 2U : 0U) + (C0 ? 1U : 
0U);
```


# **EEPROM AND SHADOW MEMORY USAGE**

The device uses EEPROM to permanently store configuration parameters for operation. EEPROM is user-programmable and permanently stores operation parameter values or customer information. The operation parameters are downloaded to shadow (volatile) memory at power-up. Shadow fields are initially loaded from corresponding fields in EEPROM, but can be overwritten, either by performing an extended write to the shadow addresses, or by reprogramming the corresponding EEPROM fields and power cycling the IC. Use of Shadow Memory is substantially faster than accessing EEPROM. In situations where many parameter need to be tested quickly, shadow memory is recommended for trying parameter values before permanently programming them into EEPROM. The shadow memory registers have the same format as the EEPROM and are accessed at extended addresses 0x40 higher than the equivalent EEPROM address. Unused bits in the EEPROM do not exist in the related shadow register, and will return 0 when read. Shadow registers do not contain the ECC bits. Shadow registers have the same protection restrictions as the EEPROM. All registers can be read without unlocking. The mapping of bits from registers addresses in EEPROM to their corresponding register addresses in SHADOW is shown in the EEPROM table (See "EEPROM table" section).

# **Enabling EEPROM Access**

To enable EEPROM write access after power-on-reset, a unlock code needs to be written to the serial register "keycode". This involves five write commands, which should be executed after each other:

- Write 0x00 to register 0x3C[15:8]
- Write 0x27 to register 0x3C[15:8]
- Write 0x81 to register 0x3C[15:8]
- Write 0x1F to register 0x3C[15:8]
- Write 0x77 to register 0x3C[15:8]

This needs to be done once after power-on reset if the customer intends to write to the EEPROM.

Writing to serial registers and reading from serial registers does not require anything special after power-on.

Reading all EEPROM cells is always possible.

Device must be unlocked when performing EEPROM margin checking.

## **EEPROM Write Lock**

It is possible to protect the EEPROM against accidental writes.

- Setting the EEPROM field "lock" to value 0xC ('1100' binary) will block any writes to the EEPROM, so that permanent changes are not possible anymore. Temporary changes to the setting are still possible by writing to the shadow memory, but these changes are lost after a power cycle. This lock is permanent and cannot be reversed. Reading of the settings is still possible.
- Setting the EEPROM field "lock" to value 0x3 ('0011' binary) will lock EEPROM writes AND shadow memory writes. This means none of the sensor settings can be changed anymore. This lock is permanent and cannot be reversed. Reading of the settings is still possible.

# **Write Transaction to EEPROM and Other Extended Locations**

Invoking an extended write access is a three-step process:

- 1. Write the extended address into the "ewa" register (using SPI or Manchester direct access). "ewa" is the 8-bit extended address that determines which extended memory address will be accessed.
- 2. Write the data that is to be transferred into the "ewd" registers (using SPI or Manchester direct access). This will take four SPI writes or 2 Manchester packets to load all 32 bits of data.
- 3. Invoke the extended access by writing the direct "ewcs.exw" bit with '1'.

The 32-bit of data in "ewd" are then written to the address specified in "ewa".

The bit "ewcs.wdn" can be polled to determine when the write completes. This is only necessary for EEPROM writes, which can take up to 24 ms to complete. Shadow register writes complete immediately in one system clock cycle after synchronization.



For example, to write location 0x1F in the EEPROM with 0x00A45678:

• Write 0x1F to lower 8 bits of EWA register (0x1F to EWA+1 Address 0x03)



• Write 0x00A45678 to EWD (0x00 to EWD, 0xA4 to EWD+1, 0x56 to EWD+2, 0x78 to EWD+3)



• Write 0x80 to EWCS



• Read EWCS+1 until bit 0 ("wdn") is set, or wait enough time.

In the example, register 0x08 is read, so that the second output byte is from register 0x09, and we wait for bit 0 to become '1', which happens in the last read.



If an access violation occurs (address not unlocked), the transaction will be terminated and the corresponding "rdn" or "wdn" bit set, and the "xee" warning bit will assert. The "xee" bit in the "err" register will also set if the EEPROM write aborts.



After writing to the EEPROM, verify that the write was successful by performing an EEPROM margin check.

## *EEPROM Margin Check*

Due to nonidealities in transistors, current will slowly leak into or out of EEPROM cells and can, over time, cause small changes in the stored voltage level. Variances in voltage levels of the charge pump can result in a variety of stored EEPROM cell voltages when programming. If this value is marginally close to the threshold, the small drift over lifetime can cause this value to move across the threshold. This results in a corrupted EEPROM value. Since this drift happens slowly over time, if there is an issue, it may not appear for years. For this reason, it is important to perform margin testing (margining) to verify the internal voltage levels of EEPROM cells after programming, and ensure there will be no issue in the future.

Margining is performed by Allegro on all registers at final test. Since EEPROM cell voltages are only modified when writing to the cell, it is not necessary to perform margining on registers that have not been modified.

Margining is performed in two steps: the first checks the validity of the voltage stored on digital '1' cells, and the second checks the voltage stored on digital '0' cells. It is important to perform both steps to ensure there are no issues.

In order to perform margining, a value of '0b0001' must be written to the SPECIAL field of the CTRL register. This reduces the internal threshold value. Once this value is written, an EEPROM read will use this lower threshold when reading EEPROM values. Perform a read on all EEPROM registers that are being tested, and confirm they read correctly. If a stored voltage is marginal to the normal operating threshold, it will appear as a '1' when it should be a '0'.

Repeat this test with the value of '0b0010' in the SPECIAL register to raise the threshold value above normal operation. Again, read all EEPROM registers being tested. In this test, any stored high voltage that is marginal to the normal threshold will appear as a '0' when they should be '1'.

If during either test, a bit is read incorrectly, simply perform another EEPROM write of the desired values to the register, and retest the margins.

Unlike other values in the SPECIAL field, these values will persist and can be read to confirm the write was successful. As a result, the SPECIAL register must be cleared (or power cycled) to return the threshold value to its normal level.

In the figure below,  $V_{NOM(H)}$  represents the nominal voltage programmed into EEPROM cells containing a '1', and  $V_{NOM(L)}$ represents the nominal voltage programmed into EEPROM cells containing a '0'. The red and blue lines represent the actual voltage levels in the programmed cells for '1' and '0' values respectively. As can be seen, at time 0 when the margin test is run, both high and low levels still appear to be the correct value when the threshold is moved to the margin testing levels.



### **Figure 60: Example of passing programming voltages**

In the figure below, the high and low voltage levels at the time of programming are further from their target. The drift over time results in these value crossing  $V<sub>THRESH</sub>$ , and becoming corrupted. At time 0 when the margin test is run, these values fail, and would be reported as errors to be reprogrammed.







Margining is shown below as a list of high level steps. For details on performing individual steps, see the associated sections.

- 1. Clear the ERR and WARN registers.
- 2. Write new data to EEPROM as desired.
- 3. Check the following flags for communication errors: ESE, EUE, XEE, IER, CRC, BSY.
- 4. Set CTRL.special to '0001' and confirm by writing 0xA5 to CTRL.initiate\_special.
- 5. Check the following flags for communication errors: ESE, EUE, XEE, IER, CRC, BSY.
- 6. Read all EEPROM registers changed in step 1 and verify their contents.
- 7. Set CTRL.special to '0010' and confirm by writing 0xA5 to CTRL.initiate\_special.
- 8. Check the following flags for communication errors: ESE, EUE, XEE, IER, CRC, BSY.
- 9. Read all EEPROM registers changed in step 1 and verify their contents.
- 10. If any values read in steps 3/5 are not what was set in step 1, repeat steps 1-6 for erroneous registers.
- 11. Set CTRL.special to '0000', or power cycle the part.



# **Read Transaction from EEPROM and Other Extended Locations**

Extended access is provided to additional memory space via the direct registers. This access includes the EEPROM and EEPROM shadow registers. All extended registers are up to 32 bits wide. Invoking an extended read access is a three-step process:

- 1. Write the extended address to be read into the "era" register (using SPI or Manchester direct access). "era" is the 8-bit extended address that determines which extended memory address will be accessed.
- 2. Invoke the extended access by writing the direct "ercs.ext" bit with '1'. The address specified in "era" is then read, and the data is loaded into the "erd" registers.
- 3. Read the "erd" registers (using SPI or Manchester direct access) to get the extended data. This will take multiple packets to get all 32 bits.

EEPROM read accesses may take up to 2 µs to complete. The "ercs.rdn" bit can be polled to determine if the read access is complete before reading the data. Shadow register reads complete in one system clock cycle after synchronization. Do not attempt to read the "erd" registers if the read access is potentially in process, as it could change during the serial access and the data will be inconsistent. It is also possible that an SPI CRC error will be detected if the data changes during the serial read via the SPI interface.



For example, to read location 0x1F in the EEPROM:

• Write 0x1F to lower 8 bits of "era" (0x1F to "era+1", Address 0x0B)





• Read "ercs"+1 until bit 0 ("rdn") is set, or wait enough time.

In the example, register 0x0C is read, so that the last bit of the second output byte contains the "rdn" bit.



• Read "erdh" (upper 16 bits of read data)

• Read "erdl" (lower 16 bits of read data)

In the example below, the result for the data at address  $0x1F$  is  $0x58A45678$ . In this value,

- $\Box$  Bit [31:26] are the EEPROM CRC
- □ Bit [25:24] are unused and zero
- $\Box$  Bit [23:0] are the EEPROM values that can be used. These are the 24 bits containing the information 0xA45678 that was written in the EEPROM write example.



Note that it would have been possible to pipeline transactions in this example, i.e. send a new command while reading return data from the old command. This way the transaction could have been performed in 5 SPI frames instead of 8.



# **Shadow Memory Read and Write Transactions**

Shadow memory Read and Write transactions are identical to those for EEPROM. Instead of addressing to the EEPROM extended address, one must address to the Shadow Extended addresses, which are located at an offset of 0x40 above the EEPROM. Refer to the EEPROM table for all addresses.



# **PRIMARY SERIAL INTERFACE REGISTER REFERENCE**



#### **Table 15: Primary Serial Interface Registers Bits Map**

\*Addresses that span multiple bytes are addressed by the most significant byte.

### **Address 0x00:0x00 (NOP) – Null Register**





### **Address 0x02:0x03 (EWA) – Extended Write Address**



#### **WRITE\_ADDR[7:0]:**

Address to be used for an extended write. Address ranges: 0x00 - 0x1F: EEPROM (requires ≈ 24 ms following execution of a write) 0x40 - 0x5F: Shadow

#### **Address 0x04:0x05 (EWDH) – Extended Write Data High**



#### **WRITE\_DATA\_HI[15:0]:**

Upper 16 bits of data for an extended write operation.

#### **Address 0x06:0x07 (EWDL) – Extended Write Data Low**



#### **WRITE\_DATA\_LO[15:0]:**

Lower 16 bits of data for an extended write operation.

#### **Address 0x08:0x09 (EWCS) – Extended Write Control and Status**



#### **EXW[15]:**

**RDN[0]:**

Initiate extended write by writing with '1'. Sets WIP, clears WDN. Writeonly, always reads back 0.

#### **WIP[8]:**

Write in progress when '1' .

Write done when '1', clears when EXR set to '1'.



Read done when '1', clears when EXR set to '1'.

### **Address 0x0A:0x0B (ERA) – Extended Read Address**



#### **READ\_ADDR[7:0]:**

Address to be used for an extended read. Address ranges: 0x00 - 0x1F: EEPROM (requires ≈2 µs) 0x40 - 0x5F: Shadow

#### **Address 0x0C:0x0D (ERCS) – Extended Read Control and Status**



**RDN[0]:**

#### **EXR[15]:**

Initiate extended read by writing with '1'. Sets RIP, clears RDN. Writeonly, always reads back 0.

#### **RIP[8]:**

Read in progress when '1' .

### **Address 0x0E:0x0F (ERDH) – Extended Read Data High**



#### **READ\_DATA\_HI[15:0]:**

Upper 16 bits of data from extended read operation, valid when ERCS. RDN set to '1' .

### **Address 0x10:0x11 (ERDL) – Extended Read Data Low**



#### **READ\_DATA\_LO[15:0]:**

Lower 16 bits of data from extended read operation, valid when ERCS. RDN set to '1'.



### **Address 0x1E:0x1F (CTRL) – Device Control**



#### **SPECIAL[15:12]:**

Defines specific actions to be taken by the IC. Many actions will only be invoked after the CTRL.INITIATE\_SPECIAL field is written with the correct value. Aside from EEPROM margining, this field will return 0x00 on completion.



#### **CLS[10]:**

Clear Status register bits "SDN" and "BDN", when set to "1".

STA.SDN indicates that a "special access" task (i.e. CVH self-test) is completed.

STA.BDN indicates the IC has booted properly and completed any start-up self-tests.

#### **CLW[9]:**

Clear warning (WARN) register when set to "1".

Clears bits that were previously read from the WARN (register 0x26:0x27). Write-only, always returns 0.

#### **CLE[8]:**

Clear error (ERR) register when set to "1". Clears bits that were previously read from the ERR (register 0x24:25). Write-only, always returns 0.

#### **INITIATE\_SPECIAL[7:0]:**

Write after setting certain CTRL.SPECIAL bits to initiate the selected action(s).

Always returns 0's.





### **Address 0x20:0x21 (ANG) – Current Angle Reading (12 bits)**



#### **EF[14]:**

**P[12]:**

Error Flag. Will be "1" if any unmasked bit in ERR or WARN is set.



#### **UV[13]:**

Undervoltage Flag (real time). Logical OR of analog and digital UV flags (UVD and UVA flags). Conditions are realtime, but may be masked by EEPROM error mask bits.



Parity bit. Odd parity is calculated across all bits (EF, UV, ANGLE). Result is that there should always be an odd number of 1's in this 16 bit word.

### **ANGLE[11:0]:**

Angle from PLL after processing. Angle in degrees is 12-bit value × (360/4096).



#### **Address 0x22:0x23 (STA) – Device Status**



#### **RIDC[15:12]:**

Register ID bits. Used to distinguish this registers from other serial registers. Hard-coded value.



#### **DIE\_ID[9:8]:**

DIE ID, loaded from EEPROM (for multi-die packages). Used for identification purposes only. No impact on sensor functionality. Set in factory by Allegro.

#### **ROT[7]:**

Indicates observed rotation direction, based on the hysteresis logic. Valid only if Hysteresis is enabled (see EEPROM 0x1C).



#### **LPSH[6]:**

Indicates the observed rotation velocity exceeds the threshold for entering "sleep" state of LPM. Sensor will automatically enter the "WAKE" state.



#### **SDN[5]:**

Special access (from CTRL register) done. Clears to 0 when a "special command" is triggered, set 1 when complete. Can clear with CTRL.CLS  $bit = 1$ .



#### **BDN[4]:**

Boot complete. EEPROM loaded and any startup self-tests are complete. Can clear with CTRL.CLS bit = 1.



#### **LBR[3]:**

Logic BIST (LBIST) running.



#### **CSTR[2]:**

CVH Self-test running.



#### **BIP[1]:**

Boot in progress. Output values may not be valid.



#### **AOK[0]:**

Angle output is OK. Indicates the PLL is locked and stat-up sequence has completed.





### **Address 0x24:0x25 (ERR) – Device Error Flags**

This is the error register. All errors are latched, meaning they will remain high after they occurred. Errors need to be read and then cleared in order to remove them. It is important that the user clears errors so that subsequent errors become visible. This is especially important for the "RST" error flag (reset), which is always enabled after power on. Not removing it means that an unexpected reset cannot be discovered afterwards.



#### **RIDC[15:12]:**

Register ID bits. Used to distinguish this registers from other serial registers. Hard-coded value.



#### **WAR[11]:**

Warning. An unmasked bit within the WARN register is asserted. May be masked by setting MSK.WAR bit in EEPROM.



#### **STF[10]:**

Self-test failure. Indicates either LBIST or CVH self-test failed.



#### **AVG[9]:**

Angle averaging error. Indicates the ORATE value is too high for the rotation velocity, and the averaged angle value is corrupted.

The ORATE setting allows multiple angle values to be averaged together, for improved precision. This reduces the response time of the sensor, and can result in corrupted angle values is the velocity is too high.



#### **ABI[8]:**

ABI integrity fault. The quadrature integrity of the ABI could not be maintained.



#### **PLK[7]:**

PLL lost lock. This indicates the PLL is not tracking the incoming angle properly. Angle value is corrupt.



#### **ZIE[6]:**

Zero crossing integrity error—a zero crossing did not occur within the maximum time expected, likely indicating missing magnet, or extreme rotation.



#### **EUE[5]:**

EEPROM uncorrectable error. A multi-bit EEPROM read occurred. EEPROM bit errors are only checked on EEPROM load (i.e. power-up or reset).



#### **OFE[4]:**

Oscillator Frequency Error. One of the oscillator watchdogs circuits, monitoring the high frequency and low frequency oscillators has tripped.



#### **UVD[3]:**

VCC Undervoltage detector tripped. Will continue to set until fault goes away (and ERR register is cleared). This is the VCC input pin voltage.





#### **UVA[2]:**

Undervoltage detector tripped. Will continue to set until fault goes away (and ERR register is cleared). This is the analog regulator output.



#### **MSL[1]:**

Magnetic sense low fault. Magnetic sense was below the low limit threshold.

Low limit threshold is set via the COM.MAG\_THRES\_LO field in EEPROM.

By default this is set to ≈200 G.



#### **RST[0]:**

Reset condition. Sets on power-on reset or hard reset. Does not set on LBIST. Indicates volatile registers have been re-initialized.





### **Address 0x26:0x27 (WARN) – Device Warning Flags**

This is the warning register. All warnings are latched, meaning they will remain high after they occurred. Warnings need to be read and then cleared in order to remove them. Warnings indicate either communication type conditions or conditions that may result in a degradation of the angle accuracy, but are less likely than errors to indicate a corruption of the angle.



#### **RIDC[15:12]:**

Register ID bits. Used to distinguish this registers from other serial registers. Hard-coded value.



#### **IER[11]:**

Interface error. Invalid number of bits in SPI packet, or bit 15 of MOSI data = '1'. Packet was discarded. Also indicates a Manchester error.



#### **CRC[10]:**

Incoming SPI CRC error. Packet was discarded. Incoming CRC is only checked if the PWI.SC bit in EEPROM is set.



#### **SRW[8]:**

Slew rate warning. This warning is asserted if the ABI slew rate limiting is enabled and a condition that requires the limiting to be applied has occurred.

Purpose of Slew Rate Limiting is to prevent an ABI integrity error.



#### **XEE[7]:**

Extended execute error. A command initiated by an extended write failed. Write failed due to access error (not unlocked) or EEPROM write failure.



#### **TR[6]:**

Temperature out of range. The temperature sensor calculated a temperature below –60°C or above 180°C. Temperature will saturate at those limits.



#### **ESE[5]:**

EEPROM soft error. A correctable (single-bit) EEPROM read occurred. EEPROM bit errors are only checked on EEPROM load (power-on or reset).



#### **SAT[4]:**

Aggregate saturation flag. Shows that any internal signals have saturated, likely to have been cause by extremely strong or weak fields.





#### **TCW[3]:**

Turns counter warning. Over 135° of angle change between "awake" states in LPM. Indicates the rotation rate is too high for the programmed sleep time.

Sleep time may be changed via the LPC.LPM\_CYCLE\_TIME field in EEPROM.



#### **BSY[2]:**

Extended access overflow. An Extended write or Extended read was initiated before previous was done.



#### **MSH[1]:**

Magnetic sense high fault. Magnetic sense was above the high limit threshold.

High limit threshold is set via the COM.MAG\_THRES\_HI field in EEPROM.

By default this is set to ≈1200 G.



#### **TOV[0]:**

Turns Counter Overflow Error.

The turns counter surpassed its maximum value of +255/-256 full rotations.

This is equivalent to an Turns register value of ±511/-512 or +2047/-2048, depending on the resolution (180° or 45°).

Must be cleared with a turns count reset (See special commands in the CTRL register description, 0x1E).



#### **Address 0x28:0x29 (TSEN) – Temperature Sensor**



#### **RIDC[15:12]:**

Register ID bits. Used to distinguish this registers from other serial registers. Hard-coded value.



#### **TEMPERATURE[11:0]:**

Current junction temperature from internal temperature sensor relative to room temperature (signed value, 2's complement). Value is in 1/8 of a degree. Temperature °C ≈ (TSEN.TEMPERATURE / 8) + 25.0.



### **Address 0x2A:0x2B (FIELD) – Field Strength (in gauss)**



#### **RIDC[15:12]:**

Register ID bits. Used to distinguish this registers from other serial registers. Hard-coded value.



#### **GAUSS [11:0]:**

Measured field strength in gauss. Updated every 128 µs. Field reading is used for signal path adjustments internal to the IC, and provided for convenient comparison of field readings over magnetic air gap. No guarantee of accuracy is made.

In general, the A1339 field reading is ≈11% below actual gauss levels.







### **Address 0x2C:0x2D (TURNS) – Turns Counter**



#### **RIDC[15:13]:**

Register ID bits. Used to distinguish this registers from other serial registers. Hard-coded value.



#### **P[12]:**

Parity bit. Odd parity is calculated across all bits. Result is that there should always be an odd number of 1's in this 16-bit word.

#### **TURNS [11:0]:**

Signed 2's complement value. Indicates total number of turns relative to angle observed on power-up. Turns resolution set via EEPROM to either 180° or 45°.

The A1339 is capable of tracking up to 256 full mechanical rotations, independent of the resolution selected.





### **Address 0x30:0x31 (HANG) – Hysteresis Angle Value (12 bits)**



#### **EF[14]:**

Error Flag. Will be "1" if any unmasked bit in ERR or WARN is set.



#### **UV[13]:**

Undervoltage Flag (real time). Logical OR of analog and digital UV flags (UVD and UVA flags). Conditions are realtime, but may be masked by EEPROM error mask bits.



#### **P[12]:**

Parity bit. Odd parity is calculated across all bits (EF, UV, ANGLE\_HYS). Result is that there should always be an odd number of 1's in this 16 bit word.

#### **ANGLE\_HYS[11:0]:**

Angle from PLL after hysteresis processing. Angle in degrees is 12-bit value × (360/4096).

### **Address 0x32:0x33 (ANG15) – Current Angle Reading (15 bits)**



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#### **ANGLE\_15[14:0]:**

15-bit compensated angle (not rounded). Angle in degrees is a 15-bit value × (360/32768)



### **Address 0x34:0x35 (ZANG) – ZCD Angle (low power signal path)**

Angle from the ZCD signal path is used for turns counter in normal and low power mode. This angle is not compensated over temperature and will not exactly match the PLL angle value.



#### **EF[14]:**

Error Flag. Will be "1" if any unmasked bit in ERR or WARN is set.



#### **UV[13]:**

Undervoltage Flag (real time). Logical OR of analog and digital UV flags (UVD and UVA flags). Conditions are realtime, but may be masked by EEPROM error mask bits.



### **P[12]:**

Parity bit. Odd parity is calculated across all bits (EF, UV, ANGLE\_ZCD). Result is that there should always be an odd number of 1's in this 16 bit word.

#### **ANGLE\_ZCD[11:0]:**

Angle from the ZCD signal path. Not compensated. Angle in degrees is 12-bit value × (360/4096).

### **Address 0x3C:0x3D (KEY) – Key Register**



#### **KEYCODE[15:8]:**

Unlock code is entered here. Once unlocked EEPROM and Shadow registers may be written. In addition some "special" commands require a device unlock.

Unlocking requires five successive writes to the KEYCODE field, following the unlock sequence shown below.

The CUL indicates a successful unlock.



#### **CUL[0]:**

Indicates the device is unlocked.





# **EEPROM/SHADOW MEMORY TABLE**

The EEPROM/Shadow register bitmap is shown below.

All EEPROM and shadow contents can be read by the user, without unlocking. Writing requires device unlock.

#### **Table 16: EEPROM / Shadow Memory Map**



### **Address 0x18 (PWE) – PWM Error Enable**

This address space contains the PWM error enable bits. When set to "1", the PWM output will respond to errors, as set via the PWI.PEO and PWI.PES bits.



#### **TOV[12]:**

PWM turns counter overflow error enable. Duty cycle 72.5%, if PWI.PEO and PWI.PES are "1".



#### **TR[11]:**

PWM Temperature out of range error enable. Duty cycle 66.875%, if PWI.PEO and PWI.PES are "1".



#### **MSH[10]:**

PWM magnetic sense high error enable. Duty cycle 61.25%, if PWI.PEO and PWI.PES are "1".



### **SAT[9]:**

PWM saturation error enable. Duty cycle 55.625%, if PWI.PEO and PWI.PES are "1".





#### **ESE[8]:**

PWM EEPROM soft error enable. Duty cycle 50%, if PWI.PEO and PWI.PES are "1".



#### **MSL[7]:**

PWM magnetic sense low error enable. Duty cycle 44.375%, if PWI.PEO and PWI.PES are "1".



#### **UV[6]:**

PWM undervoltage error enable. Duty cycle 38.75%, if PWI.PEO and PWI.PES are "1".



#### **AVG[5]:**

PWM averaging error enable. Duty cycle 33.125%, if PWI.PEO and PWI.PES are "1".



#### **ZIE[4]:**

PWM zero crossing error enable. Duty cycle 27.5%, if PWI.PEO and PWI.PES are "1".



### **PLK[3]:**

PWM PLL lost lock error enable. Duty cycle 21.875%, if PWI.PEO and PWI.PES are "1".



#### **STF[2]:**

PWM Self test error enable. Duty cycle 16.25%, if PWI.PEO and PWI.PES are "1".



### **EUE[1]:**

PWM EEPROM uncorrectable error enable. Duty cycle 10.625%, if PWI.PEO and PWI.PES are "1".



#### **OFE[0]:**

PWM Oscillator frequency error enable. Duty cycle 5%, if PWI.PEO and PWI.PES are "1".





### **Address 0x19(ABI) – ABI Control**



#### **ABI\_SLEW\_TIME[21:16]:**

ABI slew time rate. "0" disables slew limiting. Minimum edged-to-edge time for ABI output is defined by:

 $(N + 1) \times 125$  ns

where "N" is the value of ABI\_SLEW\_TIME. This limits the maximum ABI velocity. Reducing the ABI resolution can be used to counteract this.



#### **INV[15]:**

Invert ABI/UVW signals.



#### **AHE[12]:**

ABI hysteresis enable. When "1" hysteresis is applied to the ABI or UVW angle.



#### **INDEX\_MODE[9:8]:**

Defines the width and placement of the "I" pulse in ABI.



"R" indicates the ABI quadrature resolution.



#### **WDH[7]:**

Enable ABI all high (before inversion) as error mode if oscillator frequency watchdog error trips.



#### **PLH[6]:**

Enable ABI all high (before inversion) as error mode if a PLL loss of lock is detected.



## **IOE[5]:**

Incremental output enable.




#### **UVW[4]:**

Define behavior of the ABI/UVW pins. If ABI.IOE = 1.



#### **RESOLUTION\_PAIRS[3:0]:**

Defines resolution of ABI/UVW outputs. In ABI mode, cycle resolution =  $2^{(14-n)}$  where "n" is the RESOLUTION\_PAIRS value. In UVW mode, the number of pole pairs is  $n + 1$ .





#### **Address 0x1A (MSK) – Mask Bits**

This address range contains error mask bits. When set, the applicable error condition will not assert the "EF" bit in the various angle and turns count registers.



**IER[23]:** Masks the IER flag from setting the "EF" bit.

**CRC[22]:** Masks the CRC flag from setting the "EF" bit.

**SRW[20]:** Masks the SRW flag from setting the "EF" bit.

**XEE[19]:** Masks the XEE flag from setting the "EF" bit.

**TR[18]:** Masks the TR flag from setting the "EF" bit.

**ESE[17]:** Masks the ESE flag from setting the "EF" bit.

**SAT[16]:** Masks the SAT flag from setting the "EF" bit.

**TCW[15]:** Masks the TCW flag from setting the "EF" bit.

**BSY[14]:** Masks the BSY flag from setting the "EF" bit.

**MSH[13]:** Masks the MSH flag from setting the "EF" bit.

**TOV[12]:** Masks the TOV flag from setting the "EF" bit.

**WAR[11]:** Masks the WAR flag from setting the "EF" bit. **STF[10]:**

Masks the STF flag from setting the "EF" bit.

**AVG[9]:** Masks the AVG flag from setting the "EF" bit.

**ABI[8]:** Masks the ABI flag from setting the "EF" bit.

**PLK[7]:** Masks the PLK flag from setting the "EF" bit.

**ZIE[6]:** Masks the ZIE flag from setting the "EF" bit.

**EUE[5]:** Masks the EUE flag from setting the "EF" bit.

**OFE[4]:** Masks the OFE flag from setting the "EF" bit.

**UVD[3]:** Masks the UVD flag from setting the "EF" bit.

**UVA[2]:** Masks the UVA flag from setting the "EF" bit.

**MSL[1]:** Masks the MSL flag from setting the "EF" bit.

**RST[0]:** Masks the RST flag from setting the "EF" bit.



#### **Address 0x1B (PWI) – PWM Interface Control**



#### **PEN[23]:**

PWM Enable.



**Table 17: Nominal PWM Carrier Frequencies**

#### **PWM\_BAND[22:20]:**

PWM frequency band. Defines the PWM carrier frequency when combined with PWM\_FREQ.

#### **PWM\_FREQ[19:16]:**

PWM frequency select. Defines the PWM carrier frequency when combined with PWM\_BAND.



#### **PHE[14]:**

PWM Hysteresis enable.



#### **PEO[13]:**

PWM Error Output Enable. If "1" PWM will respond to errors, as defined by the PES bit.



#### **PES[12]:**

PWM Error Select, if PEO = 1.





#### **WP\_HYS[9:8]:**

WAKE pin hysteresis. Defines the voltage difference between  $V_{\text{WAKE(HI)}}$ and V<sub>WAKE(LO)</sub>.



 $V_{\text{WAKE(LO)}} = V_{\text{WAKE(HI)}} - \text{WP\_HYS}$ , or 100 mV whichever is greater.

#### **WP\_THRES[6:4]:**

WAKE pin voltage threshold. Defines the voltage threshold of  $V_{\text{WAKE(HI)}}$ .



Together with WP\_HYS, this defines both  $V_{\text{WAKE(HI)}}$  and  $V_{\text{WAKE(LO)}}$ .

#### **Table 18: Nominal Wake Pin Threshold Levels**





Value | Description 0 | No monitoring of the incoming CRC

A1339 monitors the incoming CRC.

#### **DM[3]:**

Disable Manchester Interface.



#### **S17[1]:**

A1339 ignores the 17<sup>th</sup> SPI clock. Allows negative edge sampling at the MCU (host).

#### **Address 0x1C (ANG)**



#### **ORATE[23:20]:**

Reduces the output rate by averaging samples. 2ORATE samples will be averaged. ORATE values above 12 are reduced to 12 in the logic, meaning that up to 4096 samples = 4 ms can be selected as averaging time.



The majority of angle noise is composed of low-frequency content. Due to this, noticeable improvements in IC resolution are not observed until relativity high values of ORATE (8 or above, corresponding to 256 samples). Because of this, non-zero ORATE settings are not recommended, except in cases where sensor response time is not a major concern (i.e. low rpm applications).



#### **RD[19]:**

**SC[0]:**

Rotates die. Rotates final angle 180°. Last step in the angle algorithm. This is a convenient setting to adjust one die in a dual die package for conformance to the other die. Occurs after the Zero\_offset and RO adjustments.

1 A1339 monitors incoming CRC. Discards packet if corrupt.



#### **RO[18]:**

Rotation Direction. If set to 0, increasing angle movement is in the clockwise direction when looking down on the top of the die. If set to 1, increasing angle movement is in the counter-clockwise direction. Occurs after the Zero\_offset adjust and prior to the RD manipulation.



#### **HYSTERESIS[17:12]:**

Angle Hysteresis threshold. In 14bit resolution. Provides ≈0 to 1.384° of hysteresis.



#### **ZERO\_OFFSET[11:0]:**

Post-compensation zero offset (or DC adjust), at 12-bit resolution. This value is subtracted from the measured angle value. Operation occurs prior to the RD and RO manipulations.



#### **Address 0x1D (LPC)**



#### **T45[23]:**

Defines the resolution of the turns counter.



#### **TPMD[21]:**

Transport mode disable.



#### **LPMD[20]:**

Low Power Mode Disable.



#### **LPM\_CYCLE\_TIME[17:12]:**

Defines the length of the "sleep" state within LPM (time between "wake" states).

Sleep time =  $(N + 1) \times 8.192$  ms. The alive counter increment rate.



#### **LPM\_WAKE\_THRESHOLD[10:0]:**

Minimum sample-to-sample angle difference between WAKE states, which will force the IC to stay in the WAKE state (not go back into "sleep" mode). Also used as maximum angle difference in normal power mode to decide if the device can enter low power mode. In both cases, the angle difference is calculated over the time given in "LPM\_CYCLE\_TIME". Resolution is 11 bit, for values of 0 to 180 degrees, with resolution of (360/4096) degrees per LSB.

As the observed positional displacement between successive samples approaches 180°, the direction of rotation becomes ambiguous. Therefore, it is not recommended to set this value close to 180°.

Default value = 671 codes = 58.97°.

With the default sleep time of 98.304 ms, this equates to ≈100 RPM.



#### **Address 0x1E (COM)**



#### **LOCK[23:20]:**

EEPROM and Shadow memory lock.

Permanent lock.



#### **LBE[19]:**

Power-up Logic BIST enable. LBIST requires ≈30 ms to run.



LBIST and CVH self-test are run in parallel. Therefore if both are enabled on power-up, power-on time is ≈30 ms.

#### **CSE[18]:**

Power-up CVH self-test enable.

CVH self-test requires ≈30 ms to run.



LBIST and CVH self-test are run in parallel. Therefore, if both are enabled on power-up, power-on time is ≈30 ms.

#### **DST[13]:**

Disable Self-test initiation from the serial register.



#### **DHR[12]:**

Disable Hard reset from the serial register.



#### **MAG\_THRES\_HI[11:6]:**

Magnetic threshold high value. Determine set-point of the MSH flag. When set to 0, check is disabled.

Limit increases in 32 G increments. Set to 1184 G at factory.



#### **MAG\_THRES\_LO[5:0]:**

Magnetic threshold low value. Determine set-point of the MSL flag. When set to 0, check is disabled.

Limit increased in 16 G increments. Set to 208 G at factory.



#### **Address 0x1F (CUST)**



#### **CUSTOMER[23:0]:**

Customer EEPROM space.



### **SAFETY AND DIAGNOSTICS**

The A1339 was developed in accordance with the ASIL design flow (ISO 26262) and incorporates several internal diagnostics as well as error/warning/status flags enabling the host microntroller to assess the operational status of the die.

A short summary of the A1339 diagnostics is provided below. A complete listing and discussion of the A1339 safety features may be found in the "A1339 Safety Manual", which is available upon request.

## **Built-In Self-Tests**

The A1339 features two built-in-self-tests (BISTS) which may be configured to run at power-up and may also be initiated at any time by the system microcontroller via a serial register write. A failure of any one of the self-tests will assert the Self-Test Failure Flag, STF, within the Error register.

### **CVH SELF-TEST**

CVH self-test is a method of verifying the operation of the CVH transducer without applying an external magnetic field. This feature is useful for both manufacturing test and for integration debug. The CVH self-test is implemented by changing the switch configuration from the normal operating mode into a test configuration, allowing a test current to drive the CVH in place of the magnetic field. By changing the direction of the test current and by changing the elements in the CVH that are driven, the self-test circuit emulates a changing angle of magnetic field. The measured angle is monitored to determine a passing or failing device.

CVH self-test typically takes 30 ms to run (when run in parallel with LBIST, entire test time is 30 ms).

### **LOGIC BUILT-IN SELF-TEST (LBIST)**

Logic BIST is implemented to verify the integrity of the A1339 logic. It can be executed in parallel with the CVH self-test. LBIST is effectively a form of auto-driven scan. The logic to be tested is broken into 31 scan chains. The chains are fed in parallel by a 31-bit linear feedback shift register (LFSR) to generate pseudo-random data. The output of the scan chains are fed back into a multiple input shift register (MISR) that accumulates the shifted bits into a 31-bit signature.

LBIST takes  $\approx$ 30 ms to complete (when run in parallel with CHV self-test, the entire test time is  $\approx$ 30 ms).

### **Status, Error, and Warning Flags**

The A1339 features many flags used to detect faulty external or internal conditions. Table 19 briefly describes a selection.

All flags may be read through the serial registers via SPI or Manchester communication. All unmasked error flags will assert the "General Error" flag which is included in the angle register (0x20), providing a "snapshot" of the sensor's status.

Error reporting when using PWM or ABI is more limited and discussed later on.



#### **Table 19: Status and Error Flags**





#### **ERROR REPORTING IN PWM**

The PWM output can be configured to change state if certain errors occur. There are three options:

- No error reporting
- Tristate the PWM
- Halve the carrier frequency and represent the error via different duty cycles

Two EEPROM bits, "PEO" and "PES" control how errors are reported in PWM mode, both of which are in the PWS address row of EEPROM:

#### **Table 20: PWM Error Output Enable Option (PEO)**



#### **Table 21: PWM Error Select (PES)**



The error priority and corresponding duty cycle are shown in Table 22 below, with the high priority error dictating the PWM duty cycle.

Each error code must be enabled via EEPROM. This prevents losing the PWM output due to a spurious error.

The enable bits can be found within the PWE (0x18) EEPROM row.

#### **Table 22: PWM Error Duty Cycle and Priority**





#### **ERROR REPORTING IN ABI/UVW**

Error reporting when using ABI/UVW requires the transmission of angle information to be interrupted. As a result, only the two most severe errors are allowed to interrupt the pulse stream, preventing potential spurious errors from interrupting the primary mission of the IC.

As further insurance against undesired ABI/UVW interruption, error reporting must be individually enabled in EEPROM. The error conditions which may be reported are:

- Oscillator Frequency Error
- PLL Loss of Lock Error

When enabled, and an error occurs, all three ABI lines will be brought high (prior to inversion, if enabled). This is an undefined state in both ABI (if using default I mode width) and UVW.

Error reporting is enabled via the following two EEPROM bits, housed within address row 0x19.

#### **WDH[7]:**

Enable ABI all high (before inversion) as error mode if oscillator frequency watchdog error trips.



#### **PLH[6]:**

Enable ABI all high (before inversion) as error mode if a PLL loss of lock is detected.





### **APPLICATION INFORMATION**

The A1339 features SPI, PWM, ABI/UVW, and Manchester outputs. Basic reference circuits for connecting the A1339 are shown below in Figure 62.



### **ESD Performance**

Table 23 shows the ESD performance of the A1339 device. Contact Allegro for questions regarding ESD optimization.

#### **Table 23: HBM ESD Rating (per AEC-Q100 002)**



[1] With GND pins of both die shorted together, IC performs to a 4 kV level.



### **Setting the Zero-Degree Position**

When shipped from the factory, the default angle value when oriented as shown in Figure  $63$  is  $0^{\circ}$  for both die. In some cases, the end user may want to program an angle offset in the A1339 to compensate for variations in magnetic assemblies, or for applications where absolute system-level readings are required.

The internal algorithm for computing the output angle is as follows:

*Angleout = AngleRAW – ZERO\_OFFSET*

where ZERO\_OFFSET is a 12-bit field in EEPROM.

To "zero out" the A1339 reported angle, during final application calibration, position the magnet above the A1339 in the desired zero-degree position and read the reported angle. This angle becomes the necessary ZERO\_OFFSET value to "zero-out" the angle.

In some cases, it may be convenient to have a 180° offset between die. The RD field (bit 19 of EEPROM location 0x19) allows a 180° offset to be applied. When set, this bit adds 180° to the output of the die (occurs after ZERO\_OFFSET and rotation adjustments).





# **Magnetic Target Requirements**

The A1339 is designed to operate with magnets constructed with a variety of magnetic materials, geometries, and field strengths. See Table 24 for a list of common magnet dimensions.

The A1339 actively measures and adapts to its magnetic environment. This allows operation throughout a large range of field strengths (recommended range is 300 to 1000 G, operation beyond this range will not result in long term damage). Due to

the greater signal-to-noise ratio provided at higher field strengths, performance inherently increases with increasing field strength. Typical angle performance over applied field strength is shown in Figure 11 and Figure 12

**Table 24: Target Magnet Parameters**



\* A sintered Neodymium magnet with 10 mm (or greater) diameter and 2.5 mm thickness is the recommended magnet for redundant applications.



**Figure 64: Magnetic Field versus Air Gap for a magnet 6 mm in diameter and 2.5 mm thick.**

**Allegro can provide similar curves for customer application magnets upon request. Allegro recommends larger magnets for applications that require optimized accuracy performance.**

**Figure 65**



## **Magnet Misalignment**

Magnetic misalignment with the A1339 package impacts the linearity of the observed magnetic signal and consequently the resulting accuracy. The influence of mechanical misalignment may be minimized by reducing the overall airgap and by choosing a larger magnet diameter. Figure 66 shows the influence of magnet diameter of eccentricity error.

The dual die variant of the A1339 uses a stacked die approach, resulting in a common eccentricity value for both die. This eliminates the "native misalignment" present in "side-by-side" packaging options.





Typical Systemic Error versus magnet to sensor eccentricity ( $d_{axial}$ ), Note: "Systemic Error" refers to application errors in alignment and system timing. It does not refer to sensor IC device errors. The data in this graph is simulated with ideal magnetization.



**Figure 67: Rotation Direction Definition** 





**I/O STRUCTURES**



## **PACKAGE OUTLINE DRAWINGS**



**Figure 68: Package LP, 24-Pin TSSOP with Exposed Thermal Pad**





**Figure 69: Package LE, 14-Pin TSSOP**



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### **APPENDIX A: ANGLE ERROR AND DRIFT DEFINITION**

Angle error is the difference between the actual position of the magnet and the position of the magnet as measured by the angle sensor IC (without noise). This measurement is done by reading the angle sensor IC output and comparing it with a high resolution encoder (refer to Figure 70).



**Figure 70: Angle Error Definition** 

### **Angle Error Definition**

Throughout this document, the term "angle error" is used extensively. Thus, it is necessary to introduce a single angle error definition for a full magnetic rotation. The term "angle error" is calculated according to the following formula:

$$
AngleError = max(|E_{max}|, |E_{min}|)
$$

In other words, it is the maximum deviation from a perfect straight line between 0 and 360 degrees. For the purposes of a generic definition, the offset of the IC angle profile is removed prior to the error calculation (this can be seen in Figure 70). The offset itself will depend on the starting IC angle position relative to the encoder 0° and thus can differ anywhere from 0-360°.

### **Angle Drift**

Angle drift is the change in the observed angular position over temperature, relative to 25°C.

During Allegro's factory trim, drift is measured at 150°C. The value is calculated using the following formula:

$$
Angle_{Drift} = Angle_{25^{\circ}C} - Angle_{150^{\circ}C}
$$

where each Angle value is an array corresponding to 16 angular positions around a circle.



### **Figure 71: Angle Drift of 150°C in Reference to 25°C [1]**

[1] Note that the data above is simply a representation of angle drift and not real data.



# **APPENDIX B: SPI INTERFACE ERROR FLAG DESCRIPTION**

## **IER Flag**

The IER flag is located in bit 11 of the WARN serial register  $(0x26:0x27)$ . This flag is designed to assert when the IC detects an improper communication frame, via either SPI or Manchester. For the purposes of this appendix, only the behavior in regards to the SPI bus will be discussed. The IER flag will assert on the following conditions:

- An improper number of SPI clocks are detected
- The MSB of the MOSI packet is a logic '1'

#### **Table 25: WARN Serial Register**



### **Behavior When Sharing SPI lines**

The IER flag may provide an erroneous indication when sharing the SCLK line among multiple ICs. In the case where an IC is held inactive by bringing the CS line high, the inactive IC(s) will continue to count falling SCLK edges. This results in an invalid number of observed SCLK edges, and the IER flag to assert on the next SPI transaction of the IC. False IER flag assertions differ based on the size of the SPI packet.

### **SIXTEEN AND SEVENTEEN BIT SPI PACKETS**

The IER flag will always assert if, during the CS high period, the SCLK line is brought low as follows:

- At least one time if using a 16-bit SPI packet and the S17 bit is set to '0' (EEPROM 0x1B, bit 1).
	- $\Box$  Default setting for S17 is '0'.
- At least twice if using a 16-bit packet and the S17 bit is a '1'.
	- $\square$  Based on signal timing, there is a possibility that the IER flag will assert if SCLK is brought low only once with S17 set.
- At least once if using a 17-bit packet and the S17 bit is a '1'.

#### **Impact of IER flagging with 16/17 Bit Packets**

When an incorrect number of SCLK edges is observed by the IC, the following occurs:

- 1. The IER flag will trigger.
- 2. If the packet preceding the CS high time is a read:
	- A. If SCLK drops low within 70 ns of the CS rising edge, there is a possibility the read will be discarded. If this occurs, the output will correspond to the last valid read request for that device.
	- B. If the SCLK edge occurs after 70 ns of the CS rising edge, the read is not discarded, potentially corrupting the next immediate response from the device.
- 3. If the packet preceding the CS high time is a write:
	- A. If SCLK drops low within 70 ns of the CS rising edge, there is a possibility the write will be discarded.
	- B. If the SCLK edge occurs after 70 ns of the CS rising edge, the write will occur, but the IER flag will still assert.

### **TWENTY BIT SPI PACKETS**

When using 20-bit SPI packets, the IER flag may occur when the SCLK line is brought low while CS is high. The probability of a false IER flag asserting is timing dependent and will differ from device to device, but should not occur on more than 3.2% of all SPI transactions. Lab characterization has shown significantly lower assertion rates, with false flags on 0.00% to 0.80% of all SPI transactions.

### **Impact of IER flagging with a 20-Bit Packet**

When using a 20-bit SPI packet, the following will occur if an incorrect number of SCLK edges is observed:

- 1. The IER flag will trigger.
- 2. If the packet preceding the CS high time is a read:
	- A. If SCLK drops low within 70 ns of the CS rising edge, there is a possibility the read will be discarded. If this occurs, the output will correspond to the last valid read request for that device.
	- B. If the SCLK edge occurs after 70 ns of the CS rising edge, the read will take place as expected.
- 3. If the packet preceding the CS high time is a write:
	- A. If SCLK drops low within 70 ns of the CS rising edge, there is a possibility the write will be discarded.
	- B. If the SCLK edge occurs after 70 ns of the CS rising edge, the write will occur, but the IER flag will still assert.



## **Avoiding IER Flag Assertion**

The following methods may be used to avoid false IER flag assertions:

- 1. Use dedicated SCLK lines for each IC and hold the SCLK line high when CS is high.
	- A. This prevents the IC from seeing SCLK edge transitions when CS is high.



#### **Figure 72: Separate SCLK Lines**

- 2. Use a 21-bit SPI packet.
	- A. When using a 21-bit SPI packet, the IC does not count SCLK edges when the CS pin is held high. This prevents the IER flag from improperly asserting, with the exception of power-on.

### **USING A 21-BIT SPI PACKET**

No special EEPROM programming is required for the A1333/9 to support a SPI packet size of 21 bits; the master must simply send

21 SCLK pulses during the CS low period. The format of the SPI message is shown in Figure 73.

The Master Output Slave In (MOSI) signal consists of: a 1-bit Sync bit defined as a logic '0', 1-bit  $R$ /W, 6 address bits, 4 CRC bits, and an additional logic '0'. The extra logic '0' sent on the 21<sup>st</sup> clock tick effectively shifts the standard 20-bit packet left by one place value.

The Master Input Slave Out (MISO) signal consists of: 16 data bits, the contents of which are determined by the address of the register being read, 4 CRC bits, and a repeat of the MSB of the CRC value. The repeated CRC bit shifted out on the 21st clock edge should be ignored by the master when processing the CRC to validate the message contents

#### **POWER-ON BEHAVIOR WITH A 21-BIT SPI PACKET**

If the SCLK line is shared on two or more ICs, the IER flag will assert on all idle A1339 die (CS held high) after the first SPI transaction (on the bus), following power-up. This occurs independent of the 21-bit SPI packet. This spurious IER flag asserts, on the idle die, only during the first SPI transaction. All subsequent SPI transactions will process correctly. This spurious assertion will not affect any future reads or writes to the device while power is maintained. If the IC is programmed to validate the CRC on MOSI, a CRC error flag (Bit 10 of the WARN serial register) will also assert, related to the spurious detection of a bad SPI packet

Due to the initial assertion of the IER flag, it is recommended to clear all error and warning flags on all A1339 ICs following power-on (this is "good practice", independent of the false IER flag assertion). By doing this, the false IER flag is cleared, preventing it from masking a real SPI communication issue.



**Figure 73: 21-bit SPI Packet Format**



# **Additional SPI Examples**

The examples below show differing SPI implementations. All figures assume a shared SPI bus (MISO, MOSI, SCLK) between two sensors, with individual CS lines.

Figure 74 shows an example of pipelining SPI reads between two sensors, which can result in discarded packets or corrupted data when used with 16- or 17-bit SPI packets. In this example, SPI reads are bounced between Sensor 1 and Sensor 2, one frame at a time. During the interval in which the CS lines are high, the inoperative sensor will detect an incorrect number of edges, asserting the IER flag, and potentially corrupting the following read response.

Figure 75 is a modified version of the pipelining shown in Figure 74. The first read response from each sensor is known to be corrupt, and is ignored. Because of this, the second read request (which results in the first read response on the next sequence) can be a NOP command, resulting in all zeros from the device (a NOP command is a read of serial register 0x0, which is hardcoded with all 0s). Inserting a NOP command between each valid read response ensures the data placed in the SPI buffers prior to the second response is valid.

It should be noted that the IER flag will assert on every changeover to a new die (CS line) when using this implementation due to the incorrect number of SCLK edges detected during the CS high period.

Figure 76 shows a 20-bit SPI packet. This removes the potential for incorrect read data (assuming the SCLK edge occurs 70 ns or later following the CS rising edge), allowing the two sensors to be addressed in a sequential manner, one frame per each sensor. This implementation has the added advantage of including a 4-bit CRC within each response. The IER flag may still assert when using a 20-bit packet.

Figure 77 shows implementation of a 21-bit SPI packet. This removes the false IER flag assertion and any potential for incorrect data interpretation. Allegro recommends using a 21-bit SPI packet when sharing SPI lines.



Figure 74: Implementation of SPI using 16- or 17-bit packets resulting in IER flag assertion and potentially corrupted data







Figure 76: SPI Implementation using 20-bit packets; data contents are valid however IER flag may still assert







Figure 77: SPI Implementation using 21-bit packets; data contents are valid; no false IER flag generation



#### **Revision History**



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